



LM2598 SIMPLE SWITCHER® Power Converter 150-kHz 1-A Step-Down Voltage Regulator, With Features

1 Features

- 3.3-V, 5-V, 12-V, and Adjustable Output Versions
- Adjustable Version Output Voltage Range, 1.2-V to 37-V $\pm 4\%$ Max Over Line and Load Conditions
- 1-A Output Current
- Available in 7-Pin TO-220 and DDPAK (Surface Mount) Package
- Input Voltage Range Up to 40 V
- Excellent Line and Load Regulation Specifications
- 150 kHz Fixed Frequency Internal Oscillator
- Shutdown/Soft-start
- Out of Regulation Error Flag
- Error Output Delay
- Low Power Standby Mode, I_Q , Typically 85 μ A
- High Efficiency
- Uses Readily Available Standard Inductors
- Thermal Shutdown and Current Limit Protection

2 Applications

- Simple High-Efficiency Step-down (Buck) Regulator
- Efficient Preregulator for Linear Regulators
- On-Card Switching Regulators
- Positive to Negative Converter

3 Description

The LM2598 series of regulators are monolithic integrated circuits that provide all the active functions for a step-down (buck) switching regulator, capable of driving a 1-A load with excellent line and load regulation. These devices are available in fixed output voltages of 3.3 V, 5 V, 12 V, and an adjustable output version.

The LM2598 is a member of the LM259x family.

Requiring a minimum number of external components, these regulators are simple to use and include internal frequency compensation, improved line and load specifications, fixed-frequency oscillator, Shutdown/Soft-start, error flag delay and error flag output.

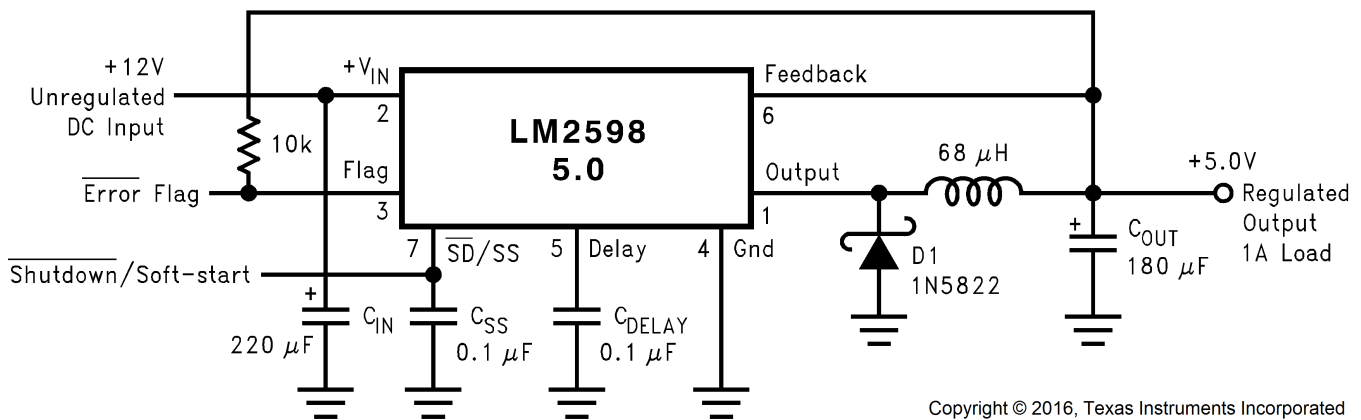
The LM2598 series operates at a switching frequency of 150 kHz, thus allowing smaller sized filter components than what would be required with lower-frequency switching regulators. Available in a standard 7-lead TO-220 package with several different lead bend options, and a 7-lead DDPAK surface mount package. Typically, for output voltages less than 12 V, and ambient temperatures less than 50°C, no heat sink is required.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LM2598	TO-220 (7)	14.986 mm $\times$ 10.16 mm
	TO-263 (7)	10.10 mm $\times$ 8.89 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Application



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Fixed output voltage versions



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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision C (April 2013) to Revision D	Page
• Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section.	1
• Removed all references to design software <i>Switchers Made Simple</i>	1

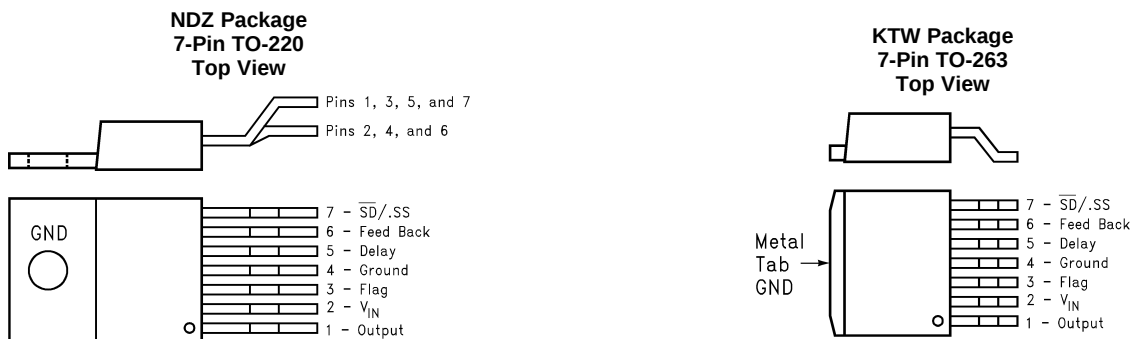
Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Semiconductor Data Sheet to TI format	38

5 Description (continued)

A standard series of inductors (both through hole and surface mount types) are available from several different manufacturers optimized for use with the LM2598. This feature greatly simplifies the design of switch-mode power supplies.

Other features include a specified $\pm 4\%$ tolerance on output voltage under all conditions of input voltage and output load conditions, and $\pm 15\%$ on the oscillator frequency. External shutdown is included, featuring typically 85- μ A standby current. Self-protection features include a two stage current limit for the output switch and an overtemperature shutdown for complete protection under fault conditions.

6 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NO.	NAME		
1	Output	O	Internal switch. The voltage at this pin switches between approximately $(+V_{IN} - V_{SAT})$ and approximately -0.5 V, with a duty cycle of V_{OUT} / V_{IN} . To minimize coupling to sensitive circuitry, the PCB copper area connected to this pin must be kept to a minimum.
2	$+V_{IN}$	I	This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents required by the regulator.
3	Error Flag	O	Open collector output that provides a low signal (flag transistor ON) when the regulated output voltage drops more than 5% from the nominal output voltage. On start up, Error Flag is low until V_{OUT} reaches 95% of the nominal output voltage and a delay time determined by the Delay pin capacitor. This signal can be used as a reset to a microprocessor on power-up. ⁽¹⁾
4	Ground	—	Circuit ground.
5	Delay	O	At power-up, this pin can be used to provide a time delay between the time the regulated output voltage reaches 95% of the nominal output voltage, and the time the error flag output goes high. ⁽¹⁾
6	Feedback	I	Senses the regulated output voltage to complete the feedback loop.
7	$\overline{\text{Shutdown/Soft-start}}$	I	This dual function pin provides the following features: (a) Allows the switching regulator circuit to be shut down using logic level signals thus dropping the total input supply current to approximately 80 μA . (b) Adding a capacitor to this pin provides a soft-start feature which minimizes start-up current and provides a controlled ramp up of the output voltage. ⁽¹⁾

(1) If any of the above three features ($\overline{\text{Shutdown/Soft-start}}$, Error Flag, or Delay) are not used, the respective pins must be left open.

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾⁽²⁾

			MIN	MAX	UNIT
Maximum supply voltage, V _{IN}				45	V
$\overline{SD}/SS$ pin input voltage ⁽³⁾				6	V
Delay pin voltage ⁽³⁾				1.5	V
Flag pin voltage			−0.3	45	V
Feedback pin voltage			−0.3	25	V
Output voltage to ground (steady state)				−1	V
Power dissipation			Internally limited		
Lead temperature	KTW package	Vapor phase (60 s)	215		°C
		Infrared (10 s)	245		
	NDZ package (soldering, 10 s)		260		
Maximum junction temperature				150	°C
Storage temperature, T _{stg}			−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) Voltage internally clamped. If clamp voltage is exceeded, limit current to a maximum of 1 mA.

7.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾⁽²⁾	±2000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) The human body model is a 100-pF capacitor discharged through a 1.5k resistor into each pin.

7.3 Recommended Operating Conditions

			MIN	MAX	UNIT
Supply voltage			4.5	40	V
Temperature			–25	125	°C

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		LM2598		UNIT
		KTW (TO-263)	NDZ (TO-220)	
		7 PINS	7 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance ⁽²⁾⁽³⁾	See ⁽⁴⁾	50	°C/W
		See ⁽⁵⁾	—	
		See ⁽⁶⁾	—	
		See ⁽⁷⁾	—	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	2	2	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) The package thermal impedance is calculated in accordance to JESD 51-7.
- (3) Thermal Resistances were simulated on a 4-layer, JEDEC board.
- (4) Junction to ambient thermal resistance (no external heat sink) for the package mounted TO-220 package mounted vertically, with the leads soldered to a printed circuit board with (1 oz.) copper area of approximately 1 in².
- (5) Junction to ambient thermal resistance with the TO-263 package tab soldered to a single sided printed circuit board with 0.5 in² of (1 oz.) copper area.
- (6) Junction to ambient thermal resistance with the TO-263 package tab soldered to a single sided printed circuit board with 2.5 in² of (1 oz.) copper area.
- (7) Junction to ambient thermal resistance with the TO-263 package tab soldered to a double sided printed circuit board with 3 in² of (1 oz.) copper area on the LM2598S side of the board, and approximately 16 in² of copper on the other side of the PCB.

7.5 Electrical Characteristics – 3.3-V Version

Specifications are for $T_J = 25^\circ\text{C}$, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
SYSTEM PARAMETERS⁽³⁾ (see Figure 42 and Figure 45 for test circuits)					
V_{OUT} Output voltage	$4.75\text{ V} \leq V_{IN} \leq 40\text{ V}$, $0.1\text{ A} \leq I_{LOAD} \leq 1\text{ A}$	$T_J = 25^\circ\text{C}$	3.168	3.3	V
		Over full operating temperature range	3.135	3.465	
η Efficiency	$V_{IN} = 12\text{ V}$, $I_{LOAD} = 1\text{ A}$		78%		

- (1) All room temperature limits are 100% production tested. All limits at temperature extremes are specified via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Typical numbers are at 25°C and represent the most likely norm.
- (3) External components such as the catch diode, inductor, input and output capacitors can affect switching regulator system performance. When the LM2598 is used as shown in the [Figure 42](#) and [Figure 45](#), system performance is as shown in system parameters of *Electrical Characteristics*.

7.6 Electrical Characteristics – 5-V Version

Specifications are for $T_J = 25^\circ\text{C}$, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
SYSTEM PARAMETERS⁽³⁾ (see Figure 42 and Figure 45 for test circuits)					
V_{OUT} Output voltage	$7\text{ V} \leq V_{IN} \leq 40\text{ V}$, $0.1\text{ A} \leq I_{LOAD} \leq 1\text{ A}$	$T_J = 25^\circ\text{C}$	4.8	5	V
		Over full operating temperature range	4.75	5.25	
η Efficiency	$V_{IN} = 12\text{ V}$, $I_{LOAD} = 1\text{ A}$		82%		

- (1) All room temperature limits are 100% production tested. All limits at temperature extremes are specified via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Typical numbers are at 25°C and represent the most likely norm.
- (3) External components such as the catch diode, inductor, input and output capacitors can affect switching regulator system performance. When the LM2598 is used as shown in the [Figure 42](#) and [Figure 45](#), system performance is as shown in system parameters of *Electrical Characteristics*.

7.7 Electrical Characteristics – 12-V Version

Specifications are for $T_J = 25^\circ\text{C}$, unless otherwise specified.

PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
SYSTEM PARAMETERS⁽³⁾ (see Figure 42 and Figure 45 for test circuits)					
V_{OUT} Output voltage	$15\text{ V} \leq V_{IN} \leq 40\text{ V}$, $0.1\text{ A} \leq I_{LOAD} \leq 1\text{ A}$	$T_J = 25^\circ\text{C}$	11.52	12	V
		Over full operating temperature range	11.4	12.6	
η Efficiency	$V_{IN} = 25\text{ V}$, $I_{LOAD} = 1\text{ A}$		90%		

- (1) All room temperature limits are 100% production tested. All limits at temperature extremes are specified via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Typical numbers are at 25°C and represent the most likely norm.
- (3) External components such as the catch diode, inductor, input and output capacitors can affect switching regulator system performance. When the LM2598 is used as shown in the [Figure 42](#) and [Figure 45](#), system performance is as shown in system parameters of *Electrical Characteristics*.

7.8 Electrical Characteristics – Adjustable Voltage Version

Specifications are for $T_J = 25^\circ\text{C}$, unless otherwise specified.

PARAMETER		TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
SYSTEM PARAMETERS⁽³⁾ (see Figure 42 and Figure 45 for test circuits)						
V_{FB}	Feedback voltage	$4.5\text{ V} \leq V_{IN} \leq 40\text{ V}$, $0.1\text{ A} \leq I_{LOAD} \leq 1\text{ A}$	1.23			V
		V_{OUT} programmed for 3 V, circuit of Figure 42 and Figure 45	1.193		1.267	
		Over full operating temperature range	1.18		1.28	
η	Efficiency	$V_{IN} = 12\text{ V}$, $V_{OUT} = 3\text{ V}$, $I_{LOAD} = 1\text{ A}$	78%			

- (1) All room temperature limits are 100% production tested. All limits at temperature extremes are specified via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Typical numbers are at 25°C and represent the most likely norm.
- (3) External components such as the catch diode, inductor, input and output capacitors can affect switching regulator system performance. When the LM2598 is used as shown in the Figure 42 and Figure 45, system performance is as shown in system parameters of *Electrical Characteristics*.

7.9 Electrical Characteristics – All Output Voltage Versions

Specifications are for $T_J = 25^\circ\text{C}$ unless otherwise noted. Unless otherwise specified, $V_{IN} = 12\text{ V}$ for the 3.3-V, 5-V, and Adjustable version and $V_{IN} = 24\text{ V}$ for the 12-V version. $I_{LOAD} = 500\text{ mA}$

PARAMETER		TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
DEVICE PARAMETERS						
I_b	Feedback bias current	Adjustable version only, $V_{FB} = 1.3\text{ V}$	$T_J = 25^\circ\text{C}$	10	50	nA
			Over full operating temperature range		100	
f_O	Oscillator frequency	See ⁽³⁾	$T_J = 25^\circ\text{C}$	127	150	kHz
			Over full operating temperature range	110	173	
V_{SAT}	Saturation voltage	$I_{OUT} = 1\text{ A}$ ⁽⁴⁾⁽⁵⁾	$T_J = 25^\circ\text{C}$	1	1.2	V
			Over full operating temperature range		1.3	
DC	Max duty cycle (ON)	See ⁽⁵⁾	100%			
	Minimum duty cycle (OFF)	See ⁽⁶⁾	0%			
I_{CL}	Current limit	Peak current ⁽⁴⁾⁽⁵⁾	$T_J = 25^\circ\text{C}$	1.2	1.5	A
			Over full operating temperature range	1.15	2.6	
I_L	Output leakage current	Output = 0 V, see ⁽⁴⁾⁽⁶⁾⁽⁷⁾	50			μA
		Output = -1 V	2			15
I_Q	Operating quiescent current	$\overline{SD}/SS$ pin open ⁽⁶⁾	5			10
I_{STBY}	Current standby quiescent	$\overline{SD}/SS$ pin = 0 V ⁽⁷⁾	$T_J = 25^\circ\text{C}$	85	200	μA
			Over full operating temperature range		250	

- (1) All room temperature limits are 100% production tested. All limits at temperature extremes are specified via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Typical numbers are at 25°C and represent the most likely norm.
- (3) The switching frequency is reduced when the second stage current limit is activated. The amount of reduction is determined by the severity of current overload.
- (4) No diode, inductor or capacitor connected to output pin.
- (5) Feedback pin removed from output and connected to 0 V to force the output transistor switch ON.
- (6) Feedback pin removed from output and connected to 12 V for the 3.3-V, 5-V, and the Adjustable version, and 15 V for the 12-V version, to force the output transistor switch OFF.
- (7) $V_{IN} = 40\text{ V}$.

Electrical Characteristics – All Output Voltage Versions (continued)

Specifications are for $T_J = 25^\circ\text{C}$ unless otherwise noted. Unless otherwise specified, $V_{IN} = 12\text{ V}$ for the 3.3-V, 5-V, and Adjustable version and $V_{IN} = 24\text{ V}$ for the 12-V version. $I_{LOAD} = 500\text{ mA}$

PARAMETER		TEST CONDITIONS		MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT		
SHUTDOWN AND SOFT-START CONTROL (see Figure 42 and Figure 45 for test circuits)									
V _{SD}	Shutdown threshold voltage	T _J = 25°C		1.3			V		
		Low, (Shutdown Mode), over full operating temperature range		0.6					
		High, (Soft-start Mode), over full operating temperature range		2					
V _{SS}	Soft-start voltage	V _{OUT} = 20% of nominal output voltage		2			V		
		V _{OUT} = 100% of nominal output voltage		3					
I _{SD}	Shutdown current	V _{SHUTDOWN} = 0.5 V		5			10	μA	
I _{SS}	Soft-start current	V _{Soft-start} = 2.5 V		1.6			5	μA	
FLAG AND DELAY CONTROL (see Figure 42 and Figure 45 for test circuits)									
	Regulator dropout detector threshold voltage	Low (Flag ON)		92%			96%	98%	
V _{F_{SAT}}	Voltage flag output saturation	I _{SINK} = 3 mA		0.3			V		
		V _{DELAY} = 0.5 V	T _J = 25°C		0.7			V	
			Over full operating temperature range		1				
I _{FL}	Flag output leakage current	V _{FLAG} = 40 V		0.3			μA		
	Voltage delay pin threshold			1.25			V		
		Low (Flag ON)		1.21			V		
		High (Flag OFF) and V _{OUT} Regulated		1.29					
	Delay pin source current	V _{DELAY} = 0.5 V		3			6	μA	
	Delay pin saturation	Low (Flag ON)	T _J = 25°C		55			350	mV
			Over full operating temperature range		400				

7.10 Typical Characteristics

Circuit of [Figure 45](#)

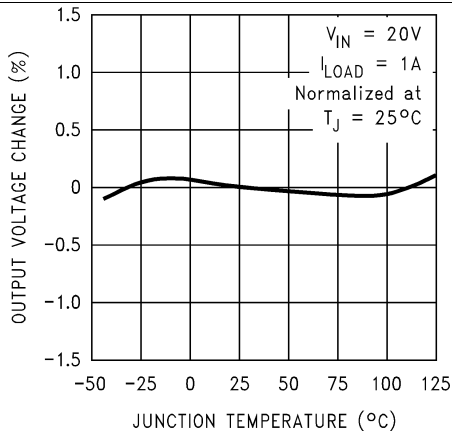


Figure 1. Normalized Output Voltage

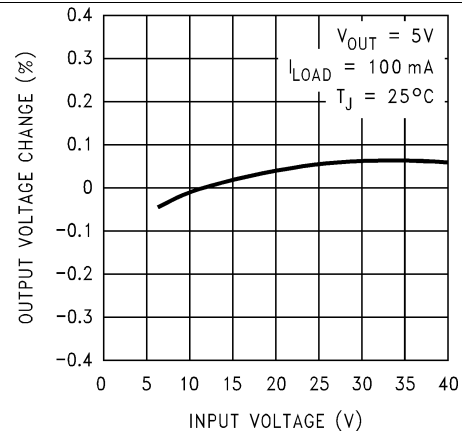


Figure 2. Line Regulation

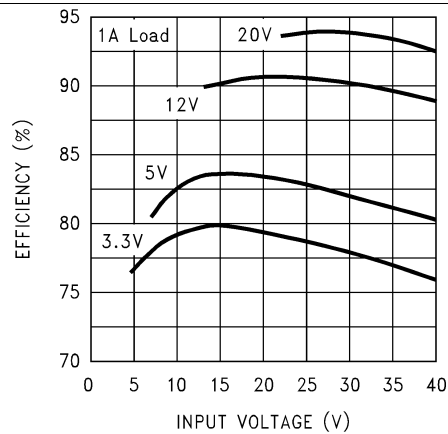


Figure 3. Efficiency

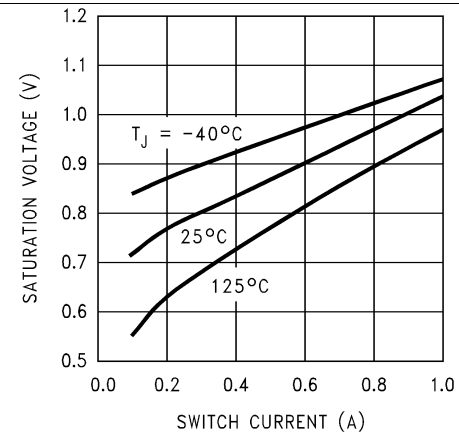


Figure 4. Switch Saturation Voltage

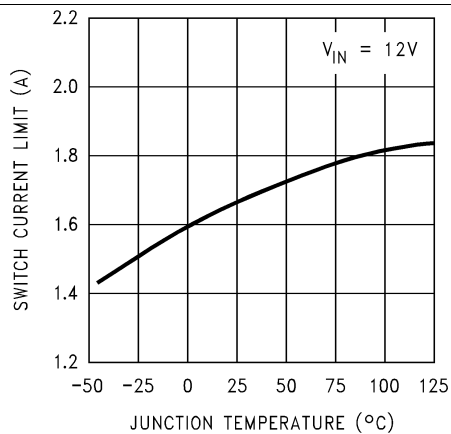


Figure 5. Switch Current Limit

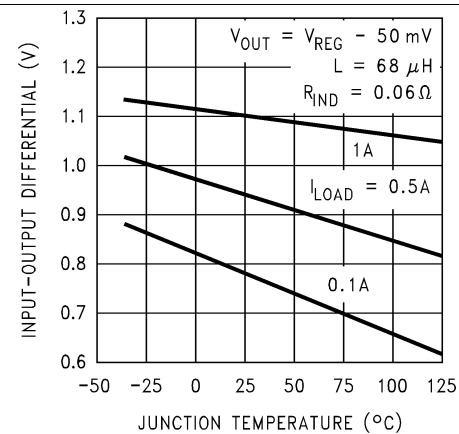


Figure 6. Dropout Voltage

Typical Characteristics (continued)

Circuit of [Figure 45](#)

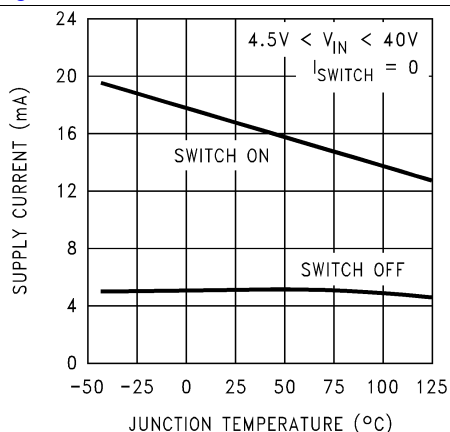


Figure 7. Operating Quiescent Current

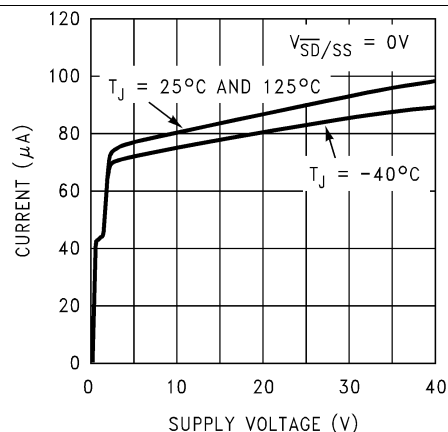


Figure 8. Shutdown Quiescent Current

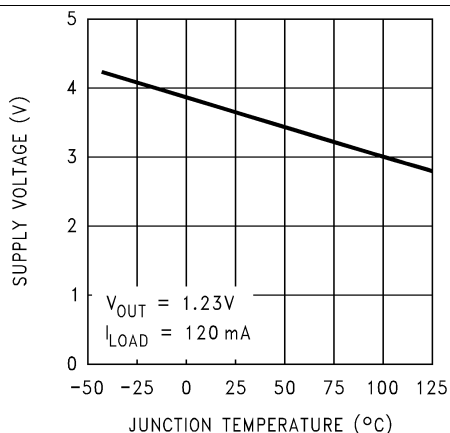


Figure 9. Minimum Operating Supply Voltage

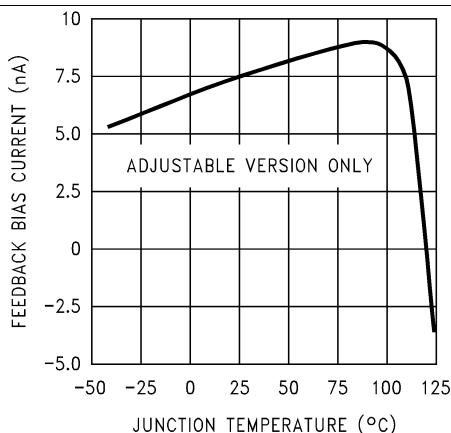


Figure 10. Feedback Pin Bias Current

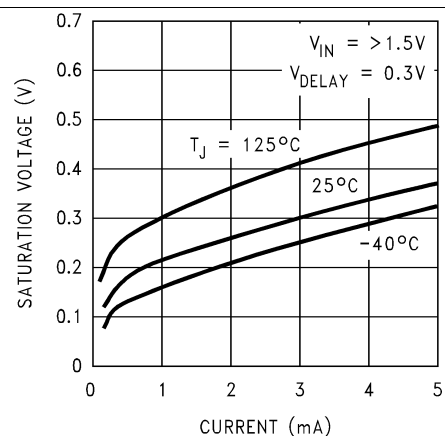


Figure 11. Flag Saturation Voltage

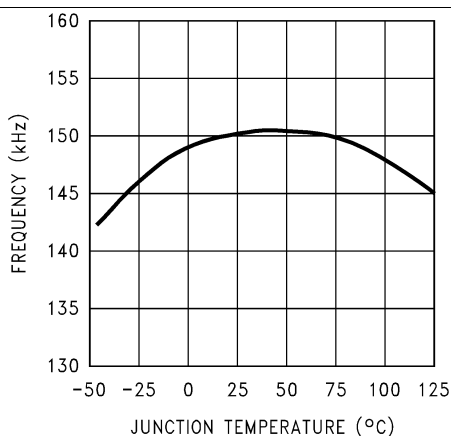
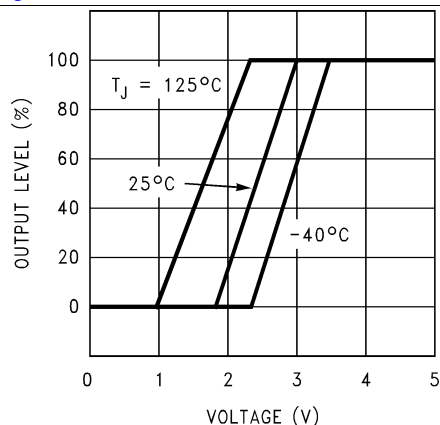
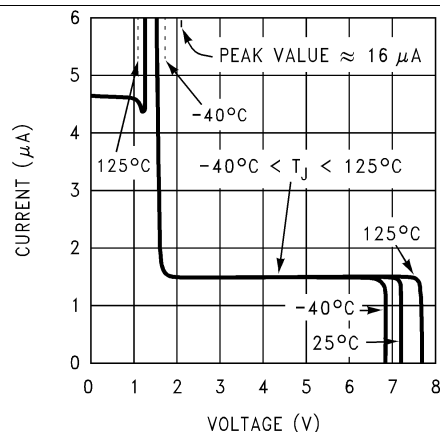
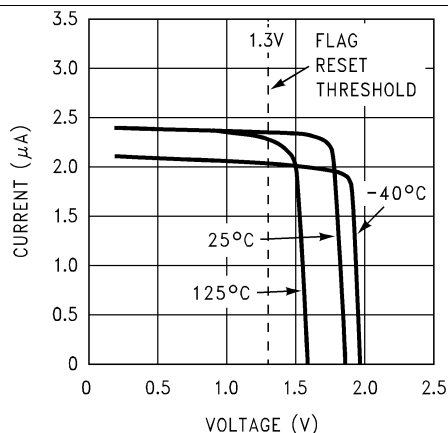
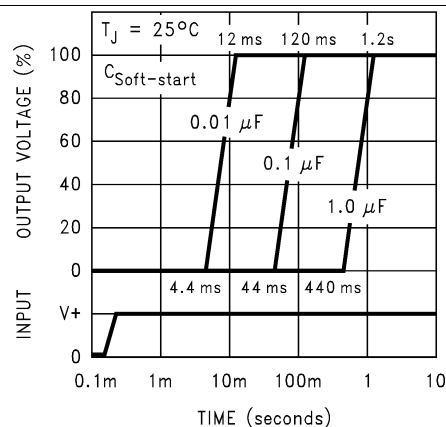
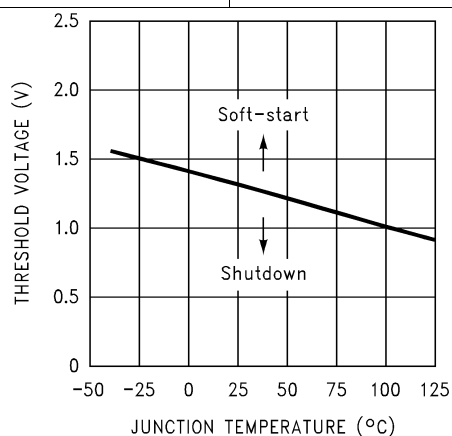


Figure 12. Switching Frequency

Typical Characteristics (continued)

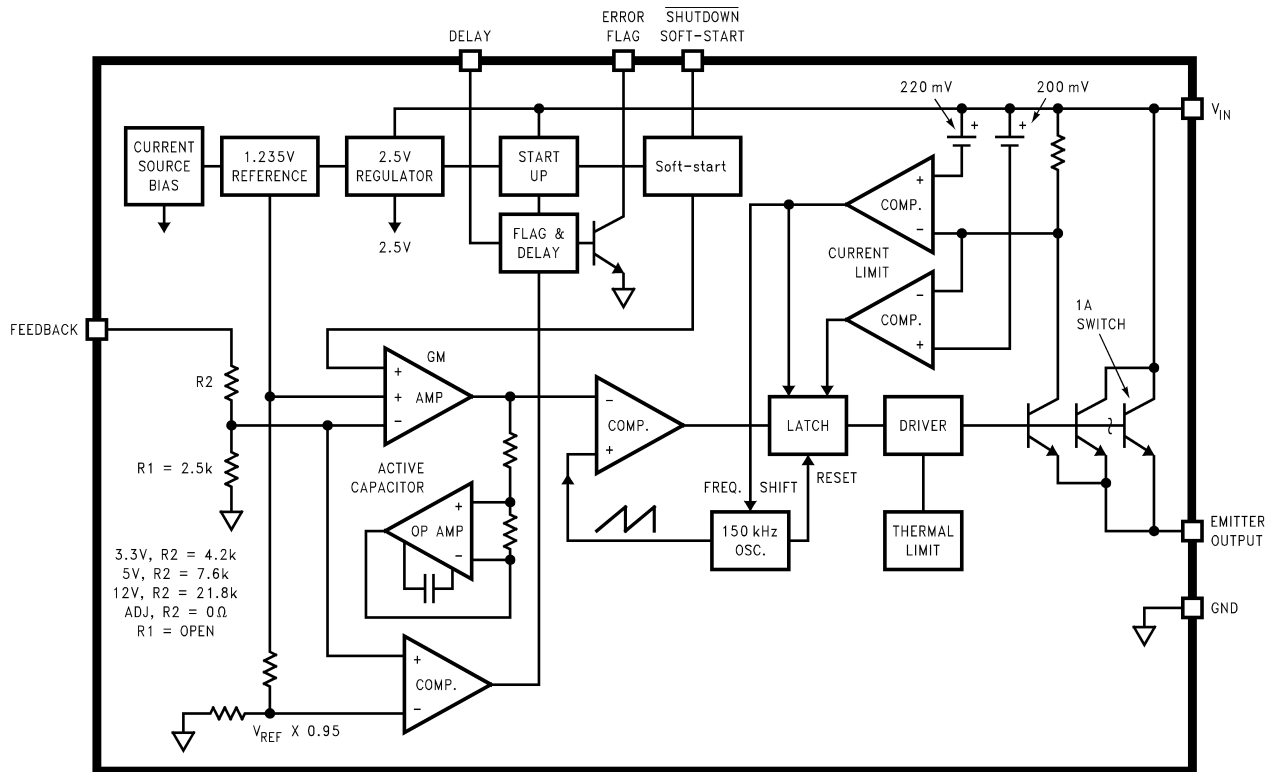
 Circuit of [Figure 45](#)

Figure 13. Soft-start

Figure 14. Shutdown/Soft-start Current

Figure 15. Delay Pin Current

Figure 16. Soft-start Response

Figure 17. Shutdown and Soft-start Threshold Voltage

8 Detailed Description

8.1 Overview

The LM2598 SIMPLE SWITCHER® regulator is an easy-to-use, nonsynchronous, step-down DC-DC converter with a wide input voltage range up to 40 V. The regulator is capable of delivering up to 1-A DC load current with excellent line and load regulation. These devices are available in fixed output voltages of 3.3-V, 5-V, 12-V and an adjustable output version. The family requires few external components, and the pin arrangement was designed for simple, optimum PCB layout.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 SHUTDOWN and Soft-Start

The circuit shown in Figure 20 is a standard buck regulator with 24-V_{IN}, 12-V_{OUT}, 280-mA load, and using a 0.068-μF soft-start capacitor. The photo in Figure 18 and Figure 19 show the effects of Soft-start on the output voltage, the input current, with, and without a soft-start capacitor. Figure 18 also shows the error flag output going high when the output voltage reaches 95% of the nominal output voltage. The reduced input current required at start-up is very evident when comparing the two photos. The Soft-start feature reduces the start-up current from 1 A down to 240 mA, and delays and slows down the output voltage rise time.

This reduction in start-up current is useful in situations where the input power source is limited in the amount of current it can deliver. In some applications Soft-start can be used to replace undervoltage lockout or delayed start-up functions.

If a very slow output voltage ramp is desired, the Soft-start capacitor can be made much larger. Many seconds or even minutes are possible.

If only the shutdown feature is required, the Soft-start capacitor can be eliminated.

Feature Description (continued)

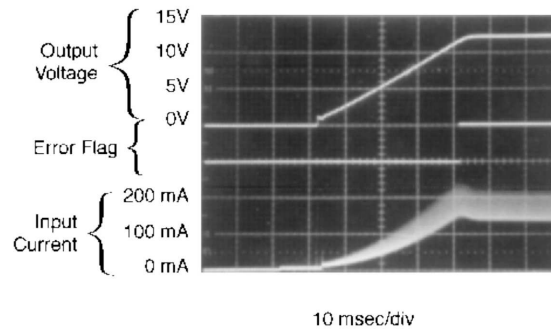


Figure 18. Output Voltage, Input Current, and Error Flag Signal at Start-Up With Soft-start

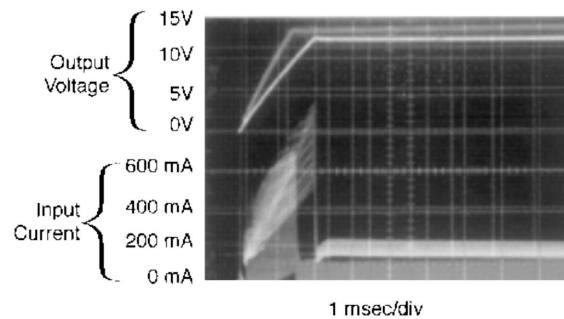


Figure 19. Output Voltage and Input Current at Start-Up Without Soft-start

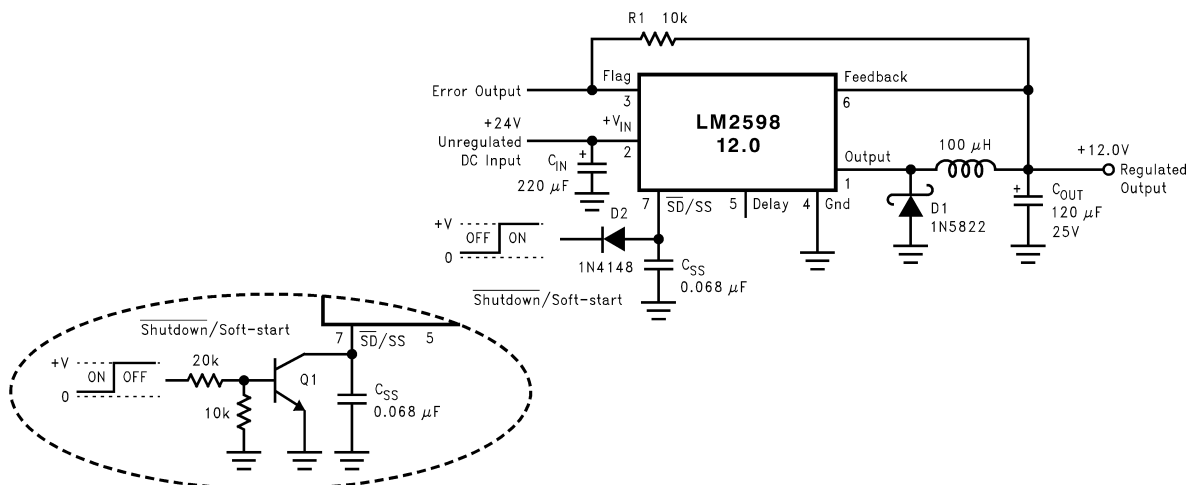


Figure 20. Typical Circuit Using Shutdown/Soft-start and Error Flag Features

Feature Description (continued)

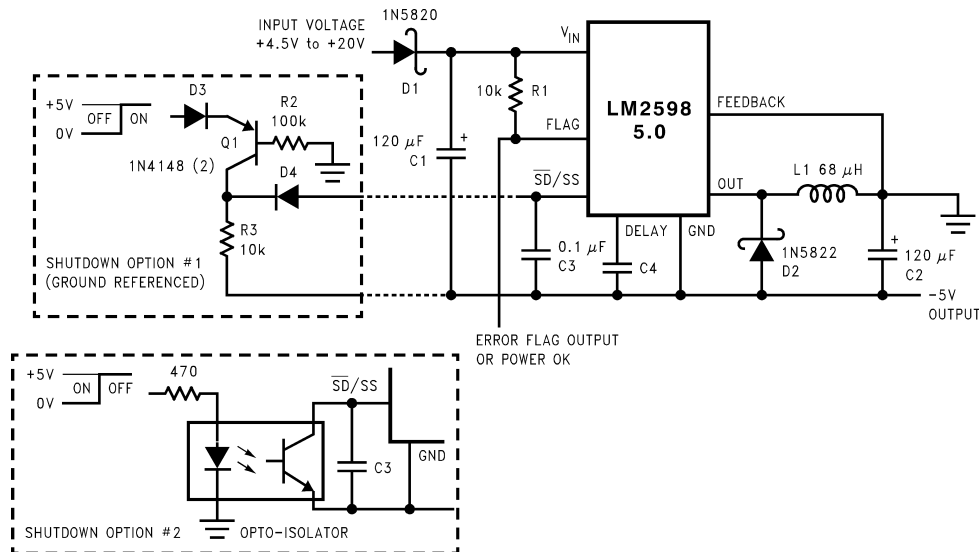


Figure 21. Inverting –5-V Regulator With Shutdown and Soft-start

8.3.2 Inverting Regulator

The circuit in [Figure 21](#) converts a positive input voltage to a negative output voltage with a common ground. The circuit operates by bootstrapping the regulators ground pin to the negative output voltage, then grounding the feedback pin, the regulator senses the inverted output voltage and regulates it.

This example uses the LM2598-5 to generate a –5-V output, but other output voltages are possible by selecting other output voltage versions, including the adjustable version. Because this regulator topology can produce an output voltage that is either greater than or less than the input voltage, the maximum output current greatly depends on both the input and output voltage. The curve shown in [Figure 22](#) provides a guide as to the amount of output load current possible for the different input and output voltage conditions.

The maximum voltage appearing across the regulator is the absolute sum of the input and output voltage, and this must be limited to a maximum of 40 V. In this example, when converting 20 V to –5 V, the regulator would see 25 V between the input pin and ground pin. The LM2598 has a maximum input voltage rating of 40 V.

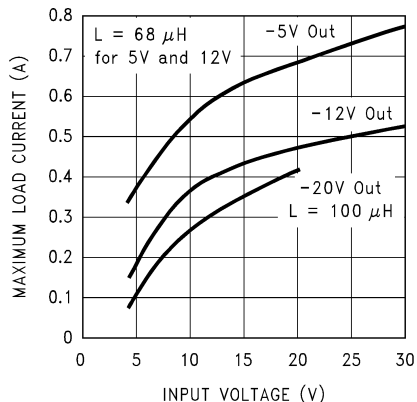


Figure 22. Maximum Load Current for Inverting Regulator Circuit

Feature Description (continued)

An additional diode is required in this regulator configuration. Diode D1 is used to isolate input voltage ripple or noise from coupling through the C_{IN} capacitor to the output, under light or no load conditions. Also, this diode isolation changes the topology to closely resemble a buck configuration thus providing good closed loop stability. A Schottky diode is recommended for low input voltages, (because of its lower voltage drop) but for higher input voltages, a 1N5400 diode could be used.

Because of differences in the operation of the inverting regulator, the standard design procedure is not used to select the inductor value. In the majority of designs, a 68- μ H, 1.5-A inductor is the best choice. Capacitor selection can also be narrowed down to just a few values. Using the values shown in [Figure 21](#) provides good results in the majority of inverting designs.

This type of inverting regulator can require relatively large amounts of input current when starting up, even with light loads. Input currents as high as the LM2598 current limit (approximately 1.5 A) are required for 2 ms or more, until the output reaches its nominal output voltage. The actual time depends on the output voltage and the size of the output capacitor. Input power sources that are current limited or sources that can not deliver these currents without getting loaded down, may not work correctly. Because of the relatively high start-up currents required by the inverting topology, the soft-start feature shown in [Figure 21](#) is recommended.

Also shown in [Figure 21](#) are several shutdown methods for the inverting configuration. With the inverting configuration, some level shifting is required, because the ground pin of the regulator is no longer at ground, but is now at the negative output voltage. The shutdown methods shown accept ground referenced shutdown signals.

8.3.3 Undervoltage Lockout

Some applications require the regulator to remain off until the input voltage reaches a predetermined voltage. [Figure 23](#) shows an undervoltage lockout feature applied to a buck regulator, while [Figure 24](#) and [Figure 25](#) are for the inverting types (only the circuitry pertaining to the undervoltage lockout is shown). [Figure 23](#) uses a Zener diode to establish the threshold voltage when the switcher begins operating. When the input voltage is less than the Zener voltage, resistors R1 and R2 hold the Shutdown or Soft-start pin low, keeping the regulator in the shutdown mode. As the input voltage exceeds the Zener voltage, the Zener conducts, pulling the Shutdown/Soft-start pin high, allowing the regulator to begin switching. The threshold voltage for the undervoltage lockout feature is approximately 1.5 V greater than the Zener voltage.

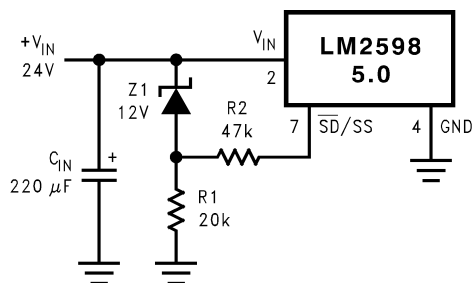


Figure 23. Undervoltage Lockout for a Buck Regulator

[Figure 24](#) and [Figure 25](#) apply the same feature to an inverting circuit. [Figure 24](#) features a constant threshold voltage for turnon and turnoff (Zener voltage plus approximately 1 V). Because the SD/SS pin has an internal 7-V zener clamp, R2 is required to limit the current into this pin to approximately 1 mA when Q1 is on. If hysteresis is required, the circuit in [Figure 25](#) has a turnon voltage which is different than the turnoff voltage. The amount of hysteresis is approximately equal to the value of the output voltage.

Feature Description (continued)

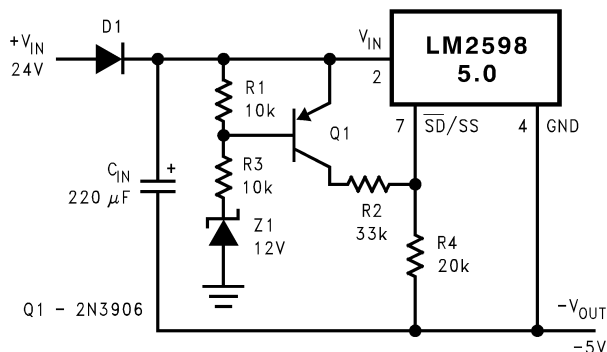


Figure 24. Undervoltage Lockout Without Hysteresis for an Inverting Regulator

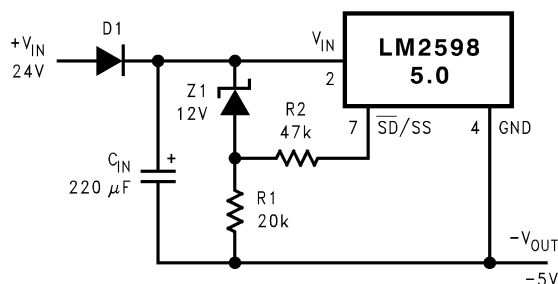


Figure 25. Undervoltage Lockout With Hysteresis for an Inverting Regulator

8.3.4 Negative Voltage Charge Pump

Occasionally a low current negative voltage is required for biasing parts of a circuit. A simple method of generating a negative voltage using a charge pump technique and the switching waveform present at the OUT pin, is shown in Figure 26. This unregulated negative voltage is approximately equal to the positive input voltage (minus a few volts), and can supply up to a 200 mA of output current. There is a requirement however, that there be a minimum load of several hundred mA on the regulated positive output for the charge pump to work correctly. Also, resistor R1 is required to limit the charging current of C1 to some value less than the LM2598 current limit (typically 1.5 A).

This method of generating a negative output voltage without an additional inductor can be used with other members of the Simple Switcher Family, using either the buck or boost topology.

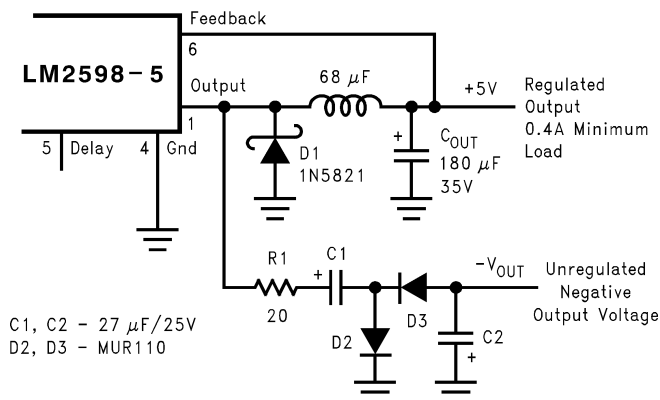


Figure 26. Charge Pump for Generating a Low Current, Negative Output Voltage

8.4 Device Functional Modes

8.4.1 Discontinuous Mode Operation

The selection guide chooses inductor values suitable for continuous mode operation, but for low current applications or high input voltages, a discontinuous mode design may be a better choice. Discontinuous mode would use an inductor that would be physically smaller, and would require only one half to one third the inductance value required for a continuous mode design. The peak switch and inductor currents is higher in a discontinuous design, but at these low load currents (200 mA and below), the maximum switch current is still less than the switch current limit.

Discontinuous operation can have voltage waveforms that are considerably different than a continuous design. The output pin (switch) waveform can have some damped sinusoidal ringing present (see [Figure 46](#)). This ringing is normal for discontinuous operation, and is not caused by feedback loop instabilities. In discontinuous operation, there is a period of time where neither the switch nor the diode are conducting, and the inductor current has dropped to zero. During this time, a small amount of energy can circulate between the inductor and the switch or diode parasitic capacitance causing this characteristic ringing. Normally this ringing is not a problem, unless the amplitude becomes great enough to exceed the input voltage, and even then, there is very little energy present to cause damage.

Different inductor types or core materials produce different amounts of this characteristic ringing. Ferrite core inductors have very little core loss and therefore produce the most ringing. The higher core loss of powdered iron inductors produce less ringing. If desired, a series RC could be placed in parallel with the inductor to dampen the ringing.

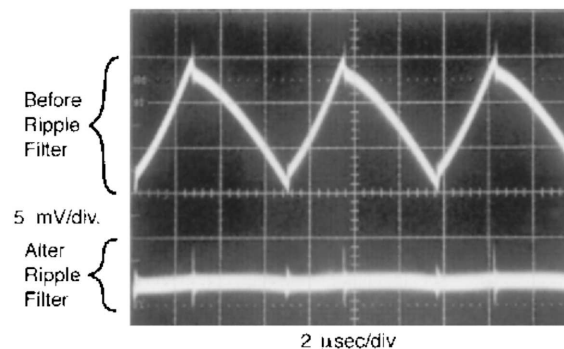


Figure 27. Post Ripple Filter Waveform

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

9.1.1 Soft-Start Capacitor (C_{SS})

A capacitor on this pin provides the regulator with a Soft-start feature (slow start-up). When the DC input voltage is first applied to the regulator, or when the Shutdown/Soft-start pin is allowed to go high, a constant current (approximately 5 μ A) begins charging this capacitor). As the capacitor voltage rises, the regulator goes through four operating regions (See the bottom curve in [Figure 28](#)).

1. Regulator in shutdown: When the $\overline{SD}/SS$ pin voltage is between 0 V and 1.3 V, the regulator is in shutdown, the output voltage is zero, and the IC quiescent current is approximately 85 μ A.
2. Regulator ON, but the output voltage is zero: With the $\overline{SD}/SS$ pin voltage between approximately 1.3 V and 1.8 V, the internal regulator circuitry is operating, the quiescent current rises to approximately 5 mA, but the output voltage is still zero. Also, as the 1.3-V threshold is exceeded, the Soft-start capacitor charging current decreases from 5 μ A down to approximately 1.6 μ A. This decreases the slope of capacitor voltage ramp.
3. Soft-start region: When the $\overline{SD}/SS$ pin voltage is between 1.8 V and 2.8 V at 25°C, the regulator is in a Soft-start condition. The switch (Pin 1) duty cycle initially starts out very low, with narrow pulses and gradually get wider as the capacitor $\overline{SD}/SS$ pin ramps up towards 2.8 V. As the duty cycle increases, the output voltage also increases at a controlled ramp up. See the center curve in [Figure 28](#). The input supply current requirement also starts out at a low level for the narrow pulses and ramp up in a controlled manner. This is a very useful feature in some switcher topologies that require large start-up currents (such as the inverting configuration) which can load down the input power supply.

Note: The lower curve shown in [Figure 28](#) shows the Soft-start region from 0% to 100%. This is not the duty cycle percentage, but the output voltage percentage. Also, the Soft-start voltage range has a negative temperature coefficient associated with it.

4. Normal operation: Above 2.8 V, the circuit operates as a standard pulse width modulated switching regulator. The capacitor continues to charge up until it reaches the internal clamp voltage of approximately 7 V. If this pin is driven from a voltage source, the current must be limited to about 1 mA.

If the part is operated with an input voltage at or below the internal soft-start clamp voltage of approximately 7 V, the voltage on the $\overline{SD}/SS$ pin tracks the input voltage and can be disturbed by a step in the voltage. To maintain proper function under these conditions, it is strongly recommended that the $\overline{SD}/SS$ pin be clamped externally between the 3-V maximum soft-start threshold and the 4.5-V minimum input voltage. [Figure 30](#) is an example of an external approximately 3.7-V clamp that prevents a line-step related glitch but does not interfere with the soft-start behavior of the device.

Application Information (continued)

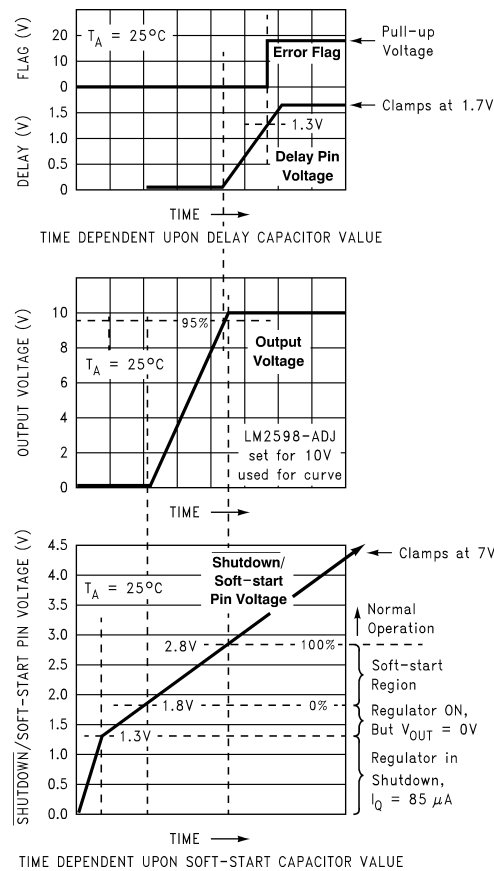


Figure 28. Soft-start, Delay, Error, Output

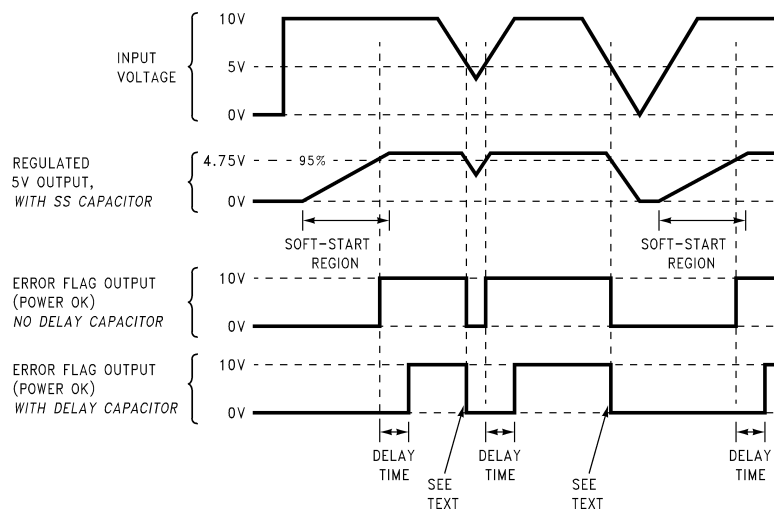


Figure 29. Timing Diagram for 5-V Output

Application Information (continued)

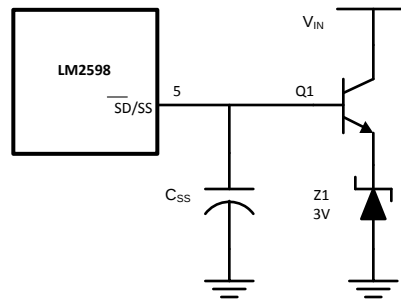


Figure 30. External 3.7-V Soft-Start Clamp

9.1.2 Delay Capacitor (C_{DELAY})

Provides delay for the error flag output. See the upper curve in [Figure 28](#), and also refer to timing diagrams in [Figure 29](#). A capacitor on this pin provides a time delay between the time the regulated output voltage (when it is increasing in value) reaches 95% of the nominal output voltage, and the time the error flag output goes high. A 3- μA constant current from the delay pin charges the delay capacitor resulting in a voltage ramp. When this voltage reaches a threshold of approximately 1.3 V, the open collector error flag output (or power OK) goes high. This signal can be used to indicate that the regulated output has reached the correct voltage and has stabilized.

If, for any reason, the regulated output voltage drops by 5% or more, the error output flag (Pin 3) immediately goes low (internal transistor turns on). The delay capacitor provides very little delay if the regulated output is dropping out of regulation. The delay time for an output that is decreasing is approximately a 1000 times less than the delay for the rising output. For a 0.1- μF delay capacitor, the delay time would be approximately 50 ms when the output is rising and passes through the 95% threshold, but the delay for the output dropping would only be approximately 50 μs .

The error flag output, $R_{\text{PULL UP}}$ (or power OK), is the collector of a NPN transistor, with the emitter internally grounded. To use the error flag, a pullup resistor to a positive voltage is required. The error flag transistor is rated up to a maximum of 45 V and can sink approximately 3 mA. If the error flag is not used, it can be left open.

9.1.3 Feedforward Capacitor (C_{FF})

NOTE

Adjustable output voltage version only

[Figure 45](#) shows a feedforward capacitor across R2 which is used when the output voltage is greater than 10 V or then C_{OUT} has a very low ESR. This capacitor adds lead compensation to the feedback loop and increases the phase margin for better loop stability.

If the output ripple is large ($> 5\%$ of the nominal output voltage), this ripple can be coupled to the feedback pin through the feedforward capacitor and cause the error comparator to trigger the error flag. In this situation, adding a resistor, R_{FF} , in series with the feedforward capacitor, approximately 3 times R1, attenuates the ripple voltage at the feedback pin.

9.1.4 Input Capacitor (C_{IN})

A low ESR aluminum or tantalum bypass capacitor is required between the input pin and ground pin. The capacitor must be located near the regulator using short leads. This capacitor prevents large voltage transients from appearing at the input, and provides the instantaneous current required each time the switch turns on.

The important parameters for the Input capacitor are the voltage rating and the RMS current rating. Because of the relatively high RMS currents flowing in a buck regulator's input capacitor, this capacitor must be chosen for its RMS current rating rather than its capacitance or voltage ratings, although the capacitance value and voltage rating are directly related to the RMS current rating.

Application Information (continued)

The RMS current rating of a capacitor could be viewed as a capacitor's power rating. The RMS current flowing through the capacitor's internal ESR produces power which causes the internal temperature of the capacitor to rise. The RMS current rating of a capacitor is determined by the amount of current required to raise the internal temperature approximately 10°C above an ambient temperature of 105°C. The ability of the capacitor to dissipate this heat to the surrounding air determines the amount of current the capacitor can safely sustain. Capacitors that are physically large and have a large surface area typically have higher RMS current ratings. For a given capacitor value, a higher voltage electrolytic capacitor is physically larger than a lower voltage capacitor, and thus be able to dissipate more heat to the surrounding air, and therefore has a higher RMS current rating.

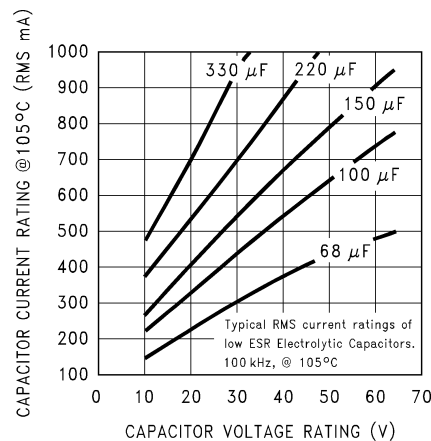


Figure 31. RMS Current Ratings for Low ESR Electrolytic Capacitors (Typical)

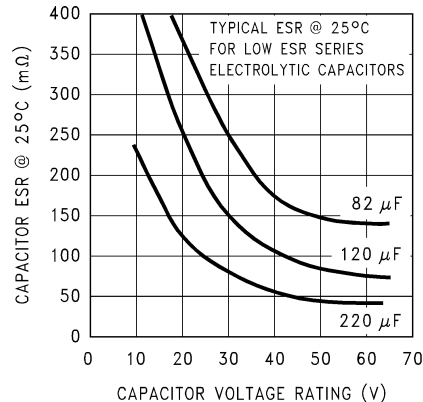


Figure 32. Capacitor ESR vs Capacitor Voltage Rating (Typical Low ESR Electrolytic Capacitor)

The consequences of operating an electrolytic capacitor above the RMS current rating is a shortened operating life. The higher temperature speeds up the evaporation of the capacitor's electrolyte, resulting in eventual failure.

Selecting an input capacitor requires consulting the manufacturers data sheet for maximum allowable RMS ripple current. For a maximum ambient temperature of 40°C, a general guideline would be to select a capacitor with a ripple current rating of approximately 50% of the DC load current. For ambient temperatures up to 70°C, a current rating of 75% of the DC load current would be a good choice for a conservative design. The capacitor voltage rating must be at least 1.25 times greater than the maximum input voltage, and often a much higher voltage capacitor is required to satisfy the RMS current requirements.

Application Information (continued)

[Figure 31](#) shows the relationship between an electrolytic capacitor value, its voltage rating, and the RMS current it is rated for. These curves were obtained from the Nichicon *PL* series of low-ESR, high-reliability electrolytic capacitors designed for switching regulator applications. Other capacitor manufacturers offer similar types of capacitors, but always check the capacitor data sheet.

Standard electrolytic capacitors typically have much higher ESR numbers, lower RMS current ratings and typically have a shorter operating lifetime.

Because of their small size and excellent performance, surface mount solid tantalum capacitors are often used for input bypassing, but several precautions must be observed. A small percentage of solid tantalum capacitors can short if the inrush current rating is exceeded. This can happen at turnon when the input voltage is suddenly applied, and of course, higher input voltages produce higher inrush currents. Several capacitor manufacturers do a 100% surge current testing on their products to minimize this potential problem. If high turnon currents are expected, it may be necessary to limit this current by adding either some resistance or inductance before the tantalum capacitor, or select a higher voltage capacitor. As with aluminum electrolytic capacitors, the RMS ripple current rating must be sized to the load current.

9.1.5 Output Capacitor (C_{OUT})

An output capacitor is required to filter the output and provide regulator loop stability. Low impedance or low ESR Electrolytic or solid tantalum capacitors designed for switching regulator applications must be used. When selecting an output capacitor, the important capacitor parameters are; the 100-kHz Equivalent Series Resistance (ESR), the RMS ripple current rating, voltage rating, and capacitance value. For the output capacitor, the ESR value is the most important parameter.

The output capacitor requires an ESR value that has an upper and lower limit. For low output ripple voltage, a low ESR value is required. This value is determined by the maximum allowable output ripple voltage, typically 1% to 2% of the output voltage. But if the selected capacitor's ESR is extremely low, there is a possibility of an unstable feedback loop, resulting in an oscillation at the output. Using the capacitors listed in the tables, or similar types, provides design solutions under all conditions.

If very low output ripple voltage (less than 15 mV) is required, see [Output Voltage Ripple and Transients](#) for a post ripple filter.

An aluminum electrolytic capacitor's ESR value is related to the capacitance value and its voltage rating. In most cases, higher voltage electrolytic capacitors have lower ESR values (see [Figure 32](#)). Often, capacitors with much higher voltage ratings may be required to provide the low ESR values required for low output ripple voltage.

The output capacitor for many different switcher designs often can be satisfied with only three or four different capacitor values and several different voltage ratings. See [Figure 38](#) and [Table 1](#) for typical capacitor values, voltage ratings, and manufacturers capacitor types.

Electrolytic capacitors are not recommended for temperatures below -25°C . The ESR rises dramatically at cold temperatures and typically rises 3X at -25°C and as much as 10X at -40°C . See curve shown in [Figure 33](#).

Solid tantalum capacitors have a much better ESR specifications for cold temperatures and are recommended for temperatures below -25°C .

Application Information (continued)

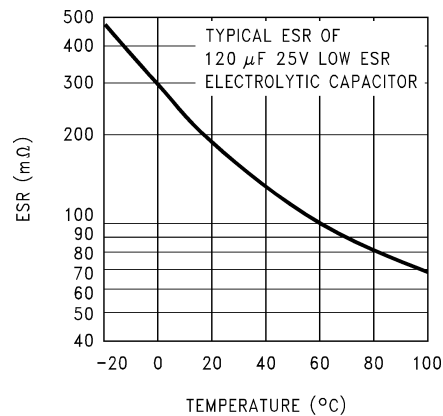
Table 1. Output Capacitor and Feedforward Capacitor Selection Table

OUTPUT VOLTAGE (V)	THROUGH-HOLE ELECTROLYTIC			SURFACE-MOUNT TANTALUM		
	PANASONIC HFQ SERIES (μF/V)	NICHICON PL SERIES (μF/V)	FEEDFORWARD CAPACITOR	AVX TPS SERIES (μF/V)	SPRAGUE 595D SERIES (μF/V)	FEEDFORWARD CAPACITOR
1.2	330/50	330/50	0	330/6.3	330/6.3	0
4	220/25	220/25	4.7 nF	220/10	220/10	4.7 nF
6	220/25	220/25	3.3 nF	220/10	220/10	3.3 nF
9	180/25	180/25	1.5 nF	100/16	180/16	1.5 nF
12	120/25	120/25	1.5 nF	68/20	120/20	1.5 nF
15	120/25	120/25	1.5 nF	68/20	100/20	1.5 nF
24	82/35	82/35	1 nF	33/25	33/35	220 pF
28	82/50	82/50	1 nF	10/35	33/35	220 pF

9.1.6 Catch Diode

Buck regulators require a diode to provide a return path for the inductor current when the switch turns off. This must be a fast diode and must be located close to the LM2598 using short leads and short printed circuit traces.

Because of their very fast switching speed and low forward voltage drop, Schottky diodes provide the best performance, especially in low output voltage applications (5 V and lower). Ultra-fast recovery, or high-efficiency rectifiers are also a good choice, but some types with an abrupt turnoff characteristic may cause instability or EMI problems. Ultra-fast recovery diodes typically have reverse recovery times of 50 ns or less. Rectifiers such as the 1N5400 series are much too slow and must not be used.


Figure 33. Capacitor ESR Change vs Temperature

9.1.7 Inductor Selection

All switching regulators have two basic modes of operation; continuous and discontinuous. The difference between the two types relates to the inductor current, whether it is flowing continuously, or if it drops to zero for a period of time in the normal switching cycle. Each mode has distinctively different operating characteristics, which can affect the regulators performance and requirements. Most switcher designs operate in the discontinuous mode when the load current is low.

The LM2598 (or any of the Simple Switcher family) can be used for both continuous or discontinuous modes of operation.

In many cases the preferred mode of operation is the continuous mode. This mode offers greater output power, lower peak switch, inductor and diode currents, and can have lower output ripple voltage. However, the continuous mode requires larger inductor values to keep the inductor current flowing continuously, especially at low output load currents or high input voltages.

To simplify the inductor selection process, an inductor selection guide (nomograph) was designed (see [Table 1](#) through [Figure 37](#)). This guide assumes that the regulator is operating in the continuous mode, and selects an inductor that allows a peak-to-peak inductor ripple current to be a certain percentage of the maximum design load current. This peak-to-peak inductor ripple current percentage is not fixed, but is allowed to change as different design load currents are selected. (See [Figure 34](#).)

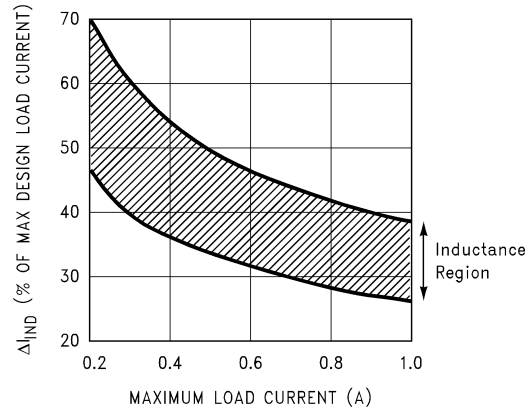


Figure 34. (ΔI_{IND}) Peak-to-Peak Inductor Ripple Current (as a Percentage of the Load Current) vs Load Current

By allowing the percentage of inductor ripple current to increase for low load currents, the inductor value and size can be kept relatively low.

When operating in the continuous mode, the inductor current waveform ranges from a triangular to a sawtooth type of waveform (depending on the input voltage), with the average value of this current waveform equal to the DC output load current.

Inductors are available in different styles such as pot core, toroid, E-core, bobbin core, and so forth, as well as different core materials, such as ferrites and powdered iron. The least expensive, the bobbin, rod or stick core, consists of wire wound on a ferrite bobbin. This type of construction makes for an inexpensive inductor; however, because the magnetic flux is not completely contained within the core, it generates more Electro-Magnetic Interference (EMI). This magnetic flux can induce voltages into nearby printed circuit traces, thus causing problems with both the switching regulator operation and nearby sensitive circuitry, and can give incorrect scope readings because of induced voltages in the scope probe. Also see [Open Core Inductors](#).

When multiple switching regulators are located on the same PCB, open core magnetics can cause interference between two or more of the regulator circuits, especially at high currents. A toroid or E-core inductor (closed magnetic structure) must be used in these situations.

The inductors listed in the selection chart include ferrite E-core construction for Schott, ferrite bobbin core for Renco and Coilcraft, and powdered iron toroid for Pulse Engineering.

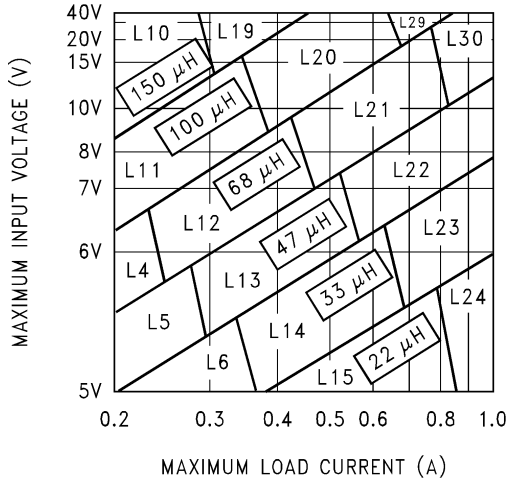
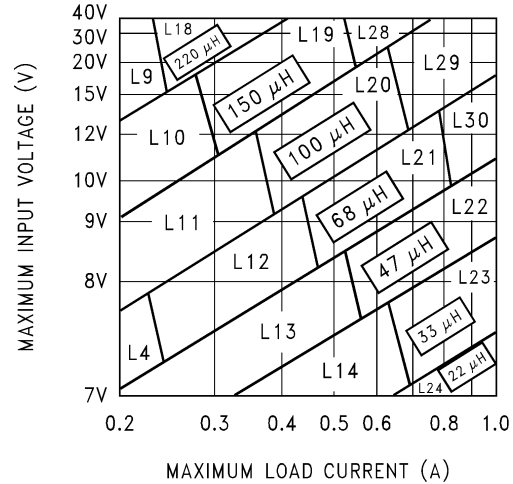
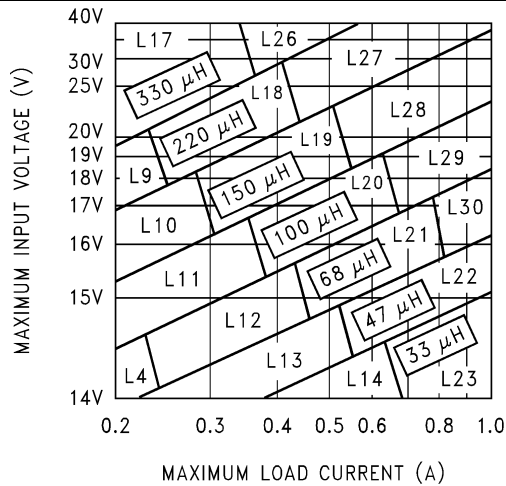
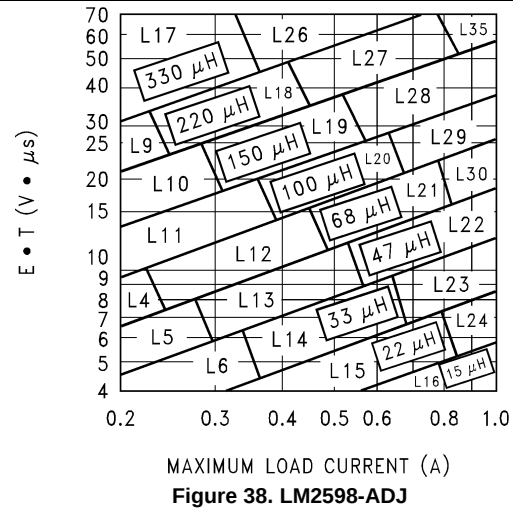
Exceeding an inductor's maximum current rating may cause the inductor to overheat because of the copper wire losses, or the core may saturate. If the inductor begins to saturate, the inductance decreases rapidly and the inductor begins to look mainly resistive (the DC resistance of the winding). This can cause the switch current to rise very rapidly and force the switch into a cycle-by-cycle current limit, thus reducing the DC output load current. This can also result in overheating of the inductor or the LM2598. Different inductor types have different saturation characteristics, and this must be kept in mind when selecting an inductor.

The inductor manufacturer's data sheets include current and energy limits to avoid inductor saturation.

For continuous mode operation, see the inductor selection graphs in [Figure 35](#) through [Figure 38](#).

LM2598

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Figure 35. LM2598-3.3

Figure 36. LM2598-5.0

Figure 37. LM2598-12

Figure 38. LM2598-ADJ
Table 2. Inductor Manufacturers Part Numbers

	INDUCTANCE (μH)	CURRENT (A)	SCHOTTKY		RENCO		PULSE ENGINEERING		COILCRAFT
			THROUGH HOLE	SURFACE MOUNT	THROUGH HOLE	SURFACE MOUNT	THROUGH HOLE	SURFACE MOUNT	SURFACE MOUNT
L4	68	0.32	67143940	67144310	RL-1284-68-43	RL1500-68	PE-53804	PE-53804-S	DO1608-68
L5	47	0.37	67148310	67148420	RL-1284-47-43	RL1500-47	PE-53805	PE-53805-S	DO1608-473
L6	33	0.44	67148320	67148430	RL-1284-33-43	RL1500-33	PE-53806	PE-53806-S	DO1608-333
L9	220	0.32	67143960	67144330	RL-5470-3	RL1500-220	PE-53809	PE-53809-S	DO3308-224
L10	150	0.39	67143970	67144340	RL-5470-4	RL1500-150	PE-53810	PE-53810-S	DO3308-154
L11	100	0.48	67143980	67144350	RL-5470-5	RL1500-100	PE-53811	PE-53811-S	DO3308-104
L12	68	0.58	67143990	67144360	RL-5470-6	RL1500-68	PE-53812	PE-53812-S	DO3308-683
L13	47	0.7	67144000	67144380	RL-5470-7	RL1500-47	PE-53813	PE-53813-S	DO3308-473
L14	33	0.83	67148340	67148450	RL-1284-33-43	RL1500-33	PE-53814	PE-53814-S	DO3308-333
L15	22	0.99	67148350	67148460	RL-1284-22-43	RL1500-22	PE-53815	PE-53815-S	DO3308-223
L16	15	1.24	67148360	67148470	RL-1284-15-43	RL1500-15	PE-53816	PE-53816-S	DO3308-153
L17	330	0.42	67144030	67144410	RL-5471-1	RL1500-330	PE-53817	PE-53817-S	DO3316-334
L18	220	0.55	67144040	67144420	RL-5471-2	RL1500-220	PE-53818	PE-53818-S	DO3316-224
L19	150	0.66	67144050	67144430	RL-5471-3	RL1500-150	PE-53819	PE-53819-S	DO3316-154
L20	100	0.82	67144060	67144440	RL-5471-4	RL1500-100	PE-53820	PE-53820-S	DO3316-104
L21	68	0.99	67144070	67144450	RL-5471-5	RL1500-68	PE-53821	PE-53821-S	DO3316-683

Table 2. Inductor Manufacturers Part Numbers (continued)

	INDUCTANCE (μ H)	CURRENT (A)	SCHOTTKY		RENCO		PULSE ENGINEERING		COILCRAFT
			THROUGH HOLE	SURFACE MOUNT	THROUGH HOLE	SURFACE MOUNT	THROUGH HOLE	SURFACE MOUNT	SURFACE MOUNT
L22	47	1.17	67144080	67144460	RL-5471-6	—	PE-53822	PE-53822-S	DO3316-473
L23	33	1.4	67144090	67144470	RL-5471-7	—	PE-53823	PE-53823-S	DO3316-333
L24	22	1.7	67148370	67144480	RL-1283-22-43	—	PE-53824	PE-53824-S	DO3316-223
L26	330	0.8	67144100	67144480	RL-5471-1	—	PE-53826	PE-53826-S	DO5022P-334
L27	220	1	67144110	67144490	RL-5471-2	—	PE-53827	PE-53827-S	DO5022P-224
L28	150	1.2	67144120	67144500	RL-5471-3	—	PE-53828	PE-53828-S	DO5022P-154
L29	100	1.47	67144130	67144510	RL-5471-4	—	PE-53829	PE-53829-S	DO5022P-104
L30	68	1.78	67144140	67144520	RL-5471-5	—	PE-53830	PE-53830-S	DO5022P-683
L35	47	2.15	67144170	—	RL-5473-1	—	PE-53935	PE-53935-S	—

9.1.8 Output Voltage Ripple and Transients

The output voltage of a switching power supply operating in the continuous mode contains a sawtooth ripple voltage at the switcher frequency, and may also contain short voltage spikes at the peaks of the sawtooth waveform.

The output ripple voltage is a function of the inductor sawtooth ripple current and the ESR of the output capacitor. A typical output ripple voltage can range from approximately 0.5% to 3% of the output voltage. To obtain low ripple voltage, the ESR of the output capacitor must be low; however, caution must be exercised when using extremely low ESR capacitors because they can affect the loop stability, resulting in oscillation problems. If very low output ripple voltage is required (less than 20 mV), TI recommends a post ripple filter (see [Figure 45](#)). The inductance required is typically between 1 μ H and 5 μ H, with low DC resistance, to maintain good load regulation. A low ESR output filter capacitor is also required to assure good dynamic load response and ripple reduction. The ESR of this capacitor may be as low as desired, because it is out of the regulator feedback loop. [Figure 27](#) shows a typical output ripple voltage, with and without a post ripple filter.

When observing output ripple with a scope, it is essential that a short, low inductance scope probe ground connection be used. Most scope probe manufacturers provide a special probe terminator which is soldered onto the regulator board, preferably at the output capacitor. This provides a very short scope ground, thus eliminating the problems associated with the 3 inch ground lead normally provided with the probe, and provides a much cleaner and more accurate picture of the ripple voltage waveform.

The voltage spikes are caused by the fast switching action of the output switch, the diode, the parasitic inductance of the output filter capacitor, and its associated wiring. To minimize these voltage spikes, the output capacitor must be designed for switching regulator applications, and the lead lengths must be kept very short. Wiring inductance, stray capacitance, as well as the scope probe used to evaluate these transients, all contribute to the amplitude of these spikes.

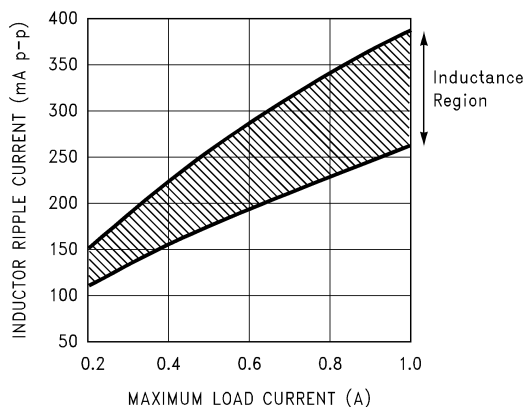


Figure 39. Peak-to-Peak Inductor Ripple Current vs Load Current

When a switching regulator is operating in the continuous mode, the inductor current waveform ranges from a triangular to a sawtooth type of waveform (depending on the input voltage). For a given input and output voltage, the peak-to-peak amplitude of this inductor current waveform remains constant. As the load current increases or decreases, the entire sawtooth current waveform also rises and falls. The average value (or the center) of this current waveform is equal to the DC load current.

If the load current drops to a low enough level, the bottom of the sawtooth current waveform reaches zero, and the switcher smoothly changes from a continuous to a discontinuous mode of operation. Most switcher designs (regardless how large the inductor value is) is forced to run discontinuous if the output is lightly loaded. This is a perfectly acceptable mode of operation.

In a switching regulator design, knowing the value of the peak-to-peak inductor ripple current (ΔI_{IND}) can be useful for determining a number of other circuit parameters. Parameters such as, peak inductor or peak switch current, minimum load current before the circuit becomes discontinuous, output ripple voltage and output capacitor ESR can all be calculated from the peak-to-peak ΔI_{IND} . When the inductor nomographs shown in [Figure 35](#) through [Figure 38](#) are used to select an inductor value, the peak-to-peak inductor ripple current can immediately be determined. [Figure 39](#) shows the range of (ΔI_{IND}) that can be expected for different load currents. [Figure 39](#) also shows how the peak-to-peak inductor ripple current (ΔI_{IND}) changes as the designer goes from the lower border to the upper border (for a given load current) within an inductance region. The upper border represents a higher input voltage, while the lower border represents a lower input voltage (see [Inductor Selection Guides](#)).

These curves are only correct for continuous mode operation, and only if the inductor selection guides are used to select the inductor value

Consider the following example:

$V_{OUT} = 5 \text{ V}$, maximum load current of 800 mA

$V_{IN} = 12 \text{ V}$, nominal, varying between 10 V and 14 V.

The selection guide in [Figure 36](#) shows that the vertical line for a 0.8-A load current and the horizontal line for the 12-V input voltage intersect approximately midway between the upper and lower borders of the 68- μH inductance region. A 68- μH inductor allows a peak-to-peak inductor current (ΔI_{IND}) to a percentage of the maximum load current. Referring to [Figure 39](#), follow the 0.8-A line approximately midway into the inductance region, and read the peak-to-peak inductor ripple current (ΔI_{IND}) on the left hand axis (approximately 300-mA p-p).

As the input voltage increases to 14 V, it approaches the upper border of the inductance region, and the inductor ripple current increases. [Figure 39](#) shows that for a load current of 0.8 A, the peak-to-peak inductor ripple current (ΔI_{IND}) is 300 mA with 12-V in, and can range from 340 mA at the upper border (14-V in) to 225 mA at the lower border (10-V in).

Once the ΔI_{IND} value is known, the following formulas can be used to calculate additional information about the switching regulator circuit.

1. Peak Inductor or peak switch current $= \left(I_{LOAD} + \frac{\Delta I_{IND}}{2} \right) = \left(0.8\text{A} + \frac{0.3}{2} \right) = 0.95\text{A}$
2. Minimum load current before the circuit becomes discontinuous $= \frac{\Delta I_{IND}}{2} = \frac{0.3}{2} = 0.15\text{A}$
3. Output Ripple Voltage $= (\Delta I_{IND}) \times (\text{ESR of } C_{OUT}) = 0.3 \text{ A} \times 0.16 \Omega = 48 \text{ mV}_{p-p}$
 $= \frac{\text{Output Ripple Voltage } (\Delta V_{OUT})}{\Delta I_{IND}}$
 $= \frac{0.048\text{V}}{0.30\text{A}} = 0.16\Omega$
4. ESR of C_{OUT}

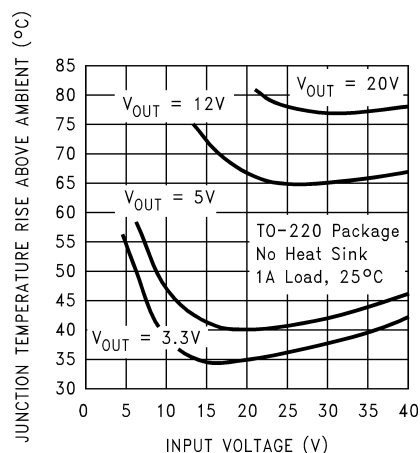
9.1.9 Open Core Inductors

Another possible source of increased output ripple voltage or unstable operation is from an open core inductor. Ferrite bobbin or stick inductors have magnetic lines of flux flowing through the air from one end of the bobbin to the other end. These magnetic lines of flux induce a voltage into any wire or PCB copper trace that comes within the magnetic field of the inductor. The strength of the magnetic field, the orientation and location of the PC copper trace to the magnetic field, and the distance between the copper trace and the inductor determine the amount of voltage generated in the copper trace. Another way of looking at this inductive coupling is to consider the PCB copper trace as one turn of a transformer (secondary) with the inductor winding as the primary. Many millivolts can be generated in a copper trace located near an open core inductor, which can cause stability problems or high output ripple voltage problems.

If unstable operation is seen, and an open core inductor is used, it is possible that the location of the inductor with respect to other PC traces may be the problem. To determine if this is the problem, temporarily raise the inductor away from the board by several inches and then check circuit operation. If the circuit now operates correctly, then the magnetic flux from the open core inductor is causing the problem. Substituting a closed-core inductor such as a torroid or E-core correct the problem, or re-arranging the PC layout may be necessary. Magnetic flux cutting the IC device ground trace, feedback trace, or the positive or negative traces of the output capacitor must be minimized.

Sometimes, placing a trace directly beneath a bobbin inductor provides good results, provided it is exactly in the center of the inductor (because the induced voltages cancel themselves out). However, problems could arise if the trace is off center. If flux problems are present, even the direction of the inductor winding can make a difference in some circuits.

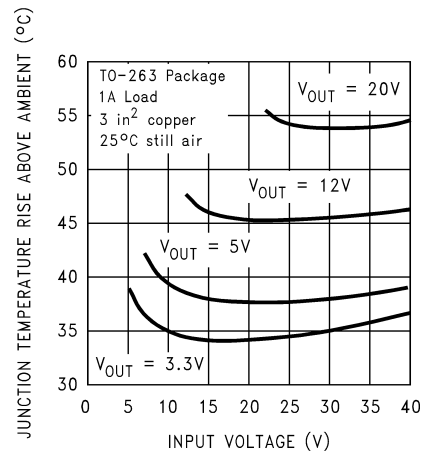
This discussion on open core inductors is not to frighten users, but to alert them on what kind of problems to watch out for when using them. Open core bobbin or *stick* inductors are an inexpensive, simple way of making a compact, efficient inductor, and they are used by the millions in many different applications.



Circuit Data for Temperature Rise Curve TO-220 Package (T)

Capacitors	Through hole electrolytic
Inductor	Through hole, Schott, 68 μ H
Diode	Through hole, 3-A, 40-V, Schottky
Printed-circuit board	3 square inches single sided 2 oz. copper (0.0028")

Figure 40. Junction Temperature Rise, TO-220



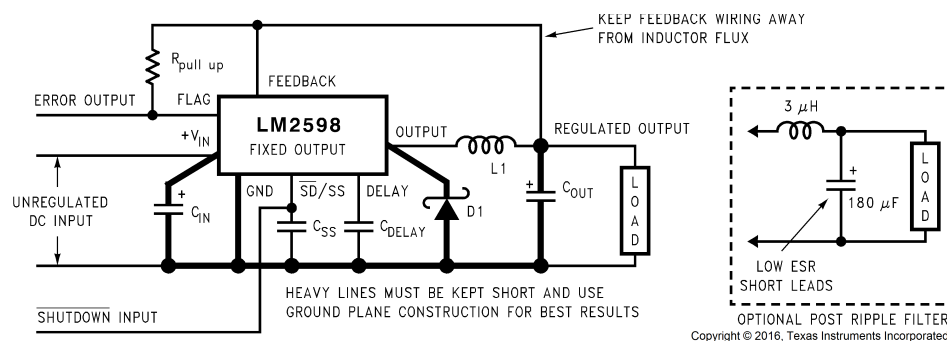
Circuit Data for Temperature Rise Curve DDPK Package (S)

Capacitors	Surface mount tantalum, molded <i>D</i> size
Inductor	Surface mount, Schott, 68 μ H
Diode	Surface mount, 3-A, 40-V, Schottky
Printed-circuit board	3 square inches single sided 2 oz. copper (0.0028")

Figure 41. Junction Temperature Rise, DDPK

9.2 Typical Application

9.2.1 LM2598 Fixed Output Series Buck Regulator



Component Values shown are for $V_{IN} = 15$ V, $V_{OUT} = 5$ V, $I_{LOAD} = 1$ A.

120- μ F, 50-V, Aluminum Electrolytic Nichicon *PL Series*

120- μ F, 35-V Aluminum Electrolytic, Nichicon *PL Series*

3-A, 40-V Schottky Rectifier, 1N5822

68- μ H, L30

Typical Values

* C_{SS} : — 0.1 μ F

C_{DELAY} : — 0.1 μ F

$R_{PULL\ Up}$: — 4.7k

Figure 42. Fixed Output Voltage Version

Typical Application (continued)

9.2.1.1 Design Requirements

Table 3 lists the design parameters of this application example.

Table 3. Design Parameters

PARAMETERS	EXAMPLE VALUE
Regulated output voltage (3.3 V, 5 V or 12 V), V_{OUT}	5 V
Maximum DC input voltage, $V_{IN(max)}$	12 V
Maximum load current, $I_{LOAD(max)}$	1 A

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Inductor Selection (L1)

1. Select the correct inductor value selection guide from [Figure 35](#), [Figure 36](#), or [Figure 37](#) (Output voltages of 3.3 V, 5 V, or 12 V respectively.) Use the inductor selection guide for the 5-V version shown in [Figure 36](#).
2. From the inductor value selection guide, identify the inductance region intersected by the maximum input voltage line and the maximum load current line. Each region is identified by an inductance value and an inductor code (LXX). From the inductor value selection guide shown in [Figure 36](#), the inductance region intersected by the 12-V horizontal line and the 1-A vertical line is 68 μ H, and the inductor code is L30.
3. Select an appropriate inductor from the four manufacturer's part numbers listed in [Table 2](#). The inductance value required is 68 μ H. See row L30 of [Table 2](#) and choose an inductor part number from any of the four manufacturers shown. (In most instance, both through hole and surface mount inductors are available.)

9.2.1.2.2 Output Capacitor Selection (C_{OUT})

1. In the majority of applications, low ESR (Equivalent Series Resistance) electrolytic capacitors between 47 μ F and 330 μ F and low ESR solid tantalum capacitors between 56 μ F and 270 μ F provide the best results. This capacitor must be located close to the IC using short capacitor leads and short copper traces. Do not use capacitors larger than 330 μ F.

For additional information, see section on output capacitors in [Output Capacitor \(\$C_{OUT}\$ \)](#) section.

2. To simplify the capacitor selection procedure, see [Figure 38](#) for quick design component selection. This table contains different input voltages, output voltages, and load currents, and lists various inductors and output capacitors that provide the best design solutions.

From [Figure 38](#), locate the 5-V output voltage section. In the load current column, choose the load current line that is closest to the current required for the application; for this example, use the 1-A line. In the maximum input voltage column, select the line that covers the input voltage required for the application; in this example, use the 15-V line. The rest of this line shows the recommended inductors and capacitors that provide the best overall performance.

The capacitor list contains both through hole electrolytic and surface mount tantalum capacitors from four different capacitor manufacturers. TI recommends using both the manufacturers and the manufacturer's series that are listed in [Figure 38](#).

In this example aluminum electrolytic capacitors from several different manufacturers are available with the range of ESR numbers required.

- 220- μ F, 25-V Panasonic HFQ Series
- 220 μ F, 25-V Nichicon PL Series

Table 4. LM2598 Fixed Voltage Quick Design Component Selection Table

CONDITIONS			INDUCTOR		OUTPUT CAPACITOR			
					THROUGH-HOLE ELECTROLYTIC		SURFACE-MOUNT TANTALUM	
OUTPUT VOLTAGE (V)	LOAD CURRENT (A)	MAX INPUT VOLTAGE (V)	INDUCTANCE (μH)	INDUCTOR (#)	PANASONIC HFQ SERIES (μF/V)	NICHICON PL SERIES (μF/V)	AVX TPS SERIES (μF/V)	SPRAGUE 595D SERIES (μF/V)
3.3	1	5	22	L24	330/16	330/16	220/10	330/10
		7	33	L23	270/25	270/25	220/10	270/10
		10	47	L31	220/25	220/35	220/10	220/10
		40	68	L30	180/35	220/35	220/10	180/10
	0.5	6	47	L13	220/25	220/16	220/16	220/10
		10	68	L21	150/35	150/25	100/16	150/16
		40	100	L20	150/35	82/35	100/16	100/20
5	1	8	33	L28	330/16	330/16	220/10	270/10
		10	47	L31	220/25	220/25	220/10	220/10
		15	68	L30	180/35	180/35	220/10	150/16
		40	100	L29	180/35	120/35	100/16	120/16
	0.5	9	68	L21	180/16	180/16	220/10	150/16
		20	150	L19	120/25	120/25	100/16	100/20
		40	150	L19	100/25	100/25	68/20	68/25
12	1	15	47	L31	220/25	220/25	68/20	120/20
		18	68	L30	180/35	120/25	68/20	120/20
		30	150	L36	82/25	82/25	68/20	100/20
		40	220	L35	82/25	82/25	68/20	68/25
	0.5	15	68	L21	180/25	180/25	68/20	120/20
		20	150	L19	82/25	82/25	68/20	100/20
		40	330	L26	56/25	56/25	68/20	68/25

- The capacitor voltage rating for electrolytic capacitors must be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are required to satisfy the low ESR requirements for low output ripple voltage

For a 5-V output, a capacitor voltage rating at least 7.5 V or more is required. But, in this example, even a low ESR, switching grade, 220-μF, 10-V aluminum electrolytic capacitor would exhibit approximately 225 mΩ of ESR (see the curve in [Figure 32](#) for the ESR vs voltage rating). This amount of ESR would result in relatively high output ripple voltage. To reduce the ripple to 1% of the output voltage, or less, a capacitor with a higher voltage rating (lower ESR) must be selected. A 16-V or 25-V capacitor reduces the ripple voltage by approximately half.

9.2.1.2.3 Catch Diode Selection (D1)

- The catch diode current rating must be at least 1.3 times greater than the maximum load current. Also, if the power supply design must withstand a continuous output short, the diode must have a current rating equal to the maximum current limit of the LM2598. The most stressful condition for this diode is an overload or shorted output condition. See [Table 5](#). In this example, a 3-A, 20-V, 1N5820 Schottky diode provides the best performance, and does not overstressed even for a shorted output.

Table 5. Diode Selection Table

VR	1-A DIODES				3-A DIODES			
	SURFACE MOUNT		THROUGH HOLE		SURFACE MOUNT		THROUGH HOLE	
	SCHOTTKY	ULTRA FAST RECOVERY	SCHOTTKY	ULTRA FAST RECOVERY	SCHOTTKY	ULTRA FAST RECOVERY	SCHOTTKY	ULTRA FAST RECOVERY
20 V	SK12	All of these diodes are rated to at least 50 V.	1N5817	All of these diodes are rated to at least 50 V.		All of these diodes are rated to at least 50 V.	IN5820	All of these diodes are rated to at least 50 V.
			SR102		SK32		SR302	
							MBR320	
30 V	SK13		1N5818				1N5821	
	MBRS130		SR103		SK33		MBR330	
			11DQ03				31DQ03	
40 V	SK14						1N5822	
	MBRS140		1N5819		SK34		SR304	
	10BQ040		SR104		MBRS340		MBR340	
	10MQ040	MURS120	11DQ04	MUR120	30WQ04	MURS320	31DQ04	MUR320
50 V or more	MBRS160	10BF10	SR105		SK35	30WF10	SR305	30WF10
	10BQ050		MBR150		MBRS360		MBR350	
	10MQ060		11DQ05		30WQ05		31DQ05	

- The reverse voltage rating of the diode must be at least 1.25 times the maximum input voltage.
- This diode must be fast (short reverse recovery time) and must be located close to the LM2598 using short leads and short printed circuit traces. Because of their fast switching speed and low forward voltage drop, Schottky diodes provide the best performance and efficiency, and must be the first choice, especially in low output voltage applications. Ultra-fast recovery, or high-efficiency rectifiers also provide good results. Ultra-fast recovery diodes typically have reverse recovery times of 50 ns or less. Rectifiers such as the 1N5400 must not be used because they are too slow.

9.2.1.2.4 Input Capacitor (C_{IN})

A low ESR aluminum or tantalum bypass capacitor is required between the input pin and ground to prevent large voltage transients from appearing at the input. In addition, the RMS current rating of the input capacitor must be selected to be at least $\frac{1}{2}$ the DC load current. The capacitor manufacturers data sheet must be checked to assure that this current rating is not exceeded. [Figure 31](#) shows typical RMS current ratings for several different aluminum electrolytic capacitor values.

This capacitor must be located close to the IC using short leads and the voltage rating must be approximately 1.5 times the maximum input voltage.

If solid tantalum input capacitors are used, TI recommends they be surge current tested by the manufacturer.

Use caution when using ceramic capacitors for input bypassing, because it may cause severe ringing at the V_{IN} pin.

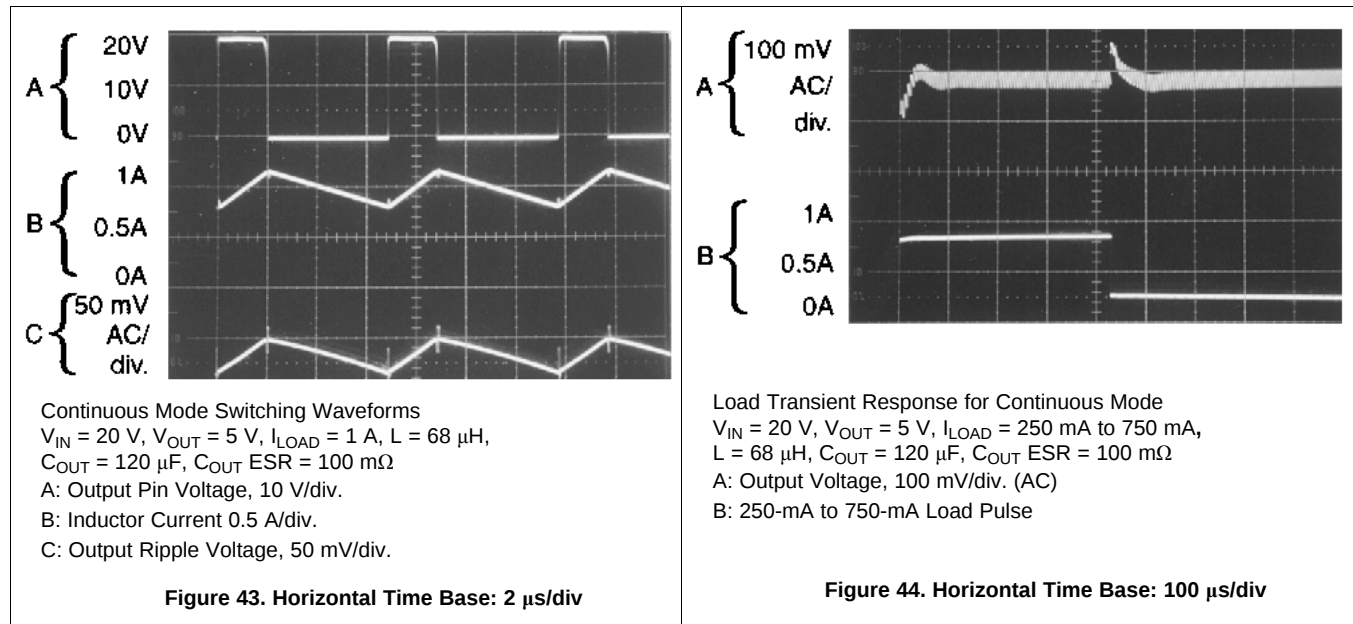
The important parameters for the Input capacitor are the input voltage rating and the RMS current rating. With a nominal input voltage of 12 V, an aluminum electrolytic capacitor with a voltage rating greater than 18 V ($1.5 \times V_{IN}$) is necessary. The next higher capacitor voltage rating is 25 V.

The RMS current rating requirement for the input capacitor in a buck regulator is approximately $\frac{1}{2}$ the DC load current. In this example, with a 1-A load, a capacitor with a RMS current rating of at least 500 mA is required. [Figure 31](#) shows curves that can be used to select an appropriate input capacitor. From the curves, locate the 25-V line and note which capacitor values have RMS current ratings greater than 500 mA. Either a 180- μ F or 220- μ F, 25-V capacitor could be used.

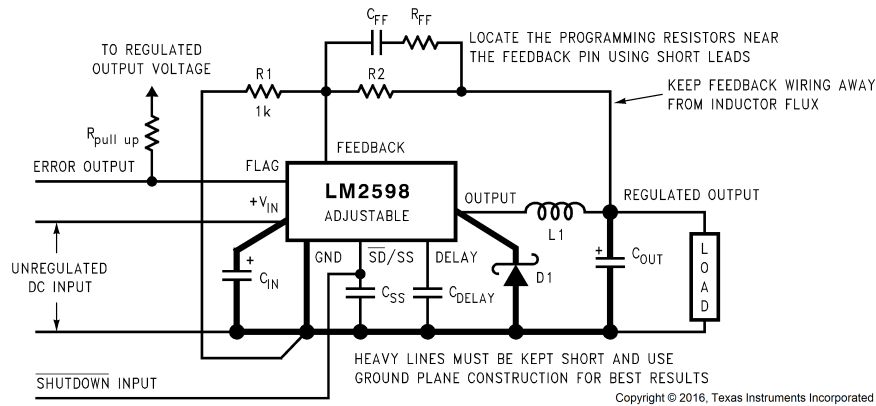
For a through-hole design, a 220- μ F, 25-V electrolytic capacitor (Panasonic HFQ series or Nichicon PL series or equivalent) would be adequate. Other types or other manufacturers' capacitors can be used provided the RMS ripple current ratings are adequate.

For surface-mount designs, solid tantalum capacitors are recommended. The TPS series available from AVX, and the 593D series from Sprague are both surge current tested.

9.2.1.3 Application Curves



9.2.2 LM2598 Adjustable Output Series Buck Regulator



$$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_1} \right)$$

where $V_{REF} = 1.23 \text{ V}$

$$R_2 = R_1 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

Select R_1 to be approximately 1 kΩ, use a 1% resistor for best stability.

Component Values shown are for $V_{IN} = 20 \text{ V}$,

$V_{OUT} = 10 \text{ V}$, $I_{LOAD} = 1 \text{ A}$.

C_{IN} — 120 μF, 35-V, Aluminum Electrolytic Nichicon *PL Series*

C_{OUT} — 120 μF, 35-V Aluminum Electrolytic, Nichicon *PL Series*

D1 —3-A, 40-V Schottky Rectifier, 1N5822

L1 —100 μH, L29

R_1 —1 kΩ, 1%

R_2 —7.1 kΩ, 1%

C_{FF} — 3.3 nF, See [Feedforward Capacitor \(\$C_{FF}\$ \)](#)

R_{FF} — 3 kΩ, See [Feedforward Capacitor \(\$C_{FF}\$ \)](#)

Typical Values

C_{SS} —0.1 μF

C_{DELAY} —0.1 μF

$R_{PULL UP}$ —4.7 kΩ

Figure 45. Adjustable Output Voltage Version

9.2.2.1 Design Requirements

Table 6 lists the design parameters for this application example.

Table 6. Design Parameters

PARAMETERS	EXAMPLE VALUE
Regulated output voltage (3.3 V, 5 V or 12 V), V_{OUT}	20 V
Maximum DC input voltage, $V_{IN(max)}$	28 V
Maximum load current, $I_{LOAD(max)}$	1 A
Switching frequency, F	Fixed at a nominal 150 kHz

9.2.2.2 Detailed Design Procedure

9.2.2.2.1 Programming Output Voltage

Select R_1 and R_2 , as shown in [Figure 45](#).

Use [Equation 1](#) to select the appropriate resistor values.

$$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_1} \right) \quad \text{where } V_{REF} = 1.23 \text{ V} \quad (1)$$

Select a value for R_1 with [Equation 2](#) between 240 Ω and 1.5 k Ω . The lower resistor values minimize noise pickup in the sensitive feedback pin. (For the lowest temperature coefficient and the best stability with time, use 1% metal film resistors.)

$$R_2 = R_1 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) \quad (2)$$

Select R_1 with [Equation 3](#) to be 1 k Ω , 1%. Solve for R_2 .

$$R_2 = R_1 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) = 1k \left(\frac{20V}{1.23V} - 1 \right) \quad (3)$$

$R_2 = 1k (16.26 - 1) = 15.26k$, closest 1% value is 15.4 k Ω .

$R_2 = 15.4$ k Ω .

9.2.2.2.2 Inductor Selection (L1)

1. Calculate the inductor Volt • microsecond constant $E \cdot T$ (V • μ s) with [Equation 4](#).

$$E \cdot T = (V_{IN} - V_{OUT} - V_{SAT}) \cdot \frac{V_{OUT} + V_D}{V_{IN} - V_{SAT} + V_D} \cdot \frac{1000}{150 \text{ kHz}} \text{ (V} \cdot \mu\text{s)}$$

where

- V_{SAT} = internal switch saturation voltage = 1 V
 - V_D = diode forward voltage drop = 0.5 V
- (4)

Calculate the inductor Volt • microsecond constant ($E \cdot T$) with [Equation 5](#).

$$E \cdot T = (28 - 20 - 1) \cdot \frac{20 + 0.5}{28 - 1 + 0.5} \cdot \frac{1000}{150} \text{ (V} \cdot \mu\text{s)}$$

$$E \cdot T = (7) \cdot \frac{20.5}{27.6} \cdot 6.67 \text{ (V} \cdot \mu\text{s)} = 34.8 \text{ (V} \cdot \mu\text{s)} \quad (5)$$

2. Use the $E \cdot T$ value from the previous formula and match it with the $E \cdot T$ number on the vertical axis of the see the inductor selection graphs in [Figure 35](#) through [Figure 38](#).

$$E \cdot T = 34.8 \text{ (V} \cdot \mu\text{s)}$$

3. On the horizontal axis, select the maximum load current.

$$I_{LOAD(max)} = 1 \text{ A}$$

4. Identify the inductance region intersected by the $E \cdot T$ value and the Maximum Load Current value. Each region is identified by an inductance value and an inductor code (LXX).

From the inductor selection graphs in [Figure 35](#) through [Figure 38](#), the inductance region intersected by the 35 (V • μ s) horizontal line and the 1-A vertical line is 100 μ H, and the inductor code is L29.

5. Select an appropriate inductor from the four manufacturer's part numbers listed in [Table 2](#).

From the table in [Table 2](#), locate line L29, and select an inductor part number from the list of manufacturers' part numbers.

9.2.2.2.3 Output Capacitor Selection (C_{OUT})

1. In the majority of applications, low ESR electrolytic or solid tantalum capacitors between 82 μ F and 220 μ F provide the best results. This capacitor must be located close to the IC using short capacitor leads and short copper traces. Do not use capacitors larger than 220 μ F. For additional information, see [Output Capacitor \(\$C_{OUT}\$ \)](#).
2. To simplify the capacitor selection procedure, see [Table 1](#) for a quick design guide. This table contains different output voltages, and lists various output capacitors that provide the best design solutions.

From [Table 1](#), locate the output voltage column. From that column, locate the output voltage closest to the output voltage in your application. In this example, select the 24-V line. Under the [Output Capacitor \(\$C_{OUT}\$ \)](#) section, select a capacitor from the list of through hole electrolytic or surface mount tantalum types from four different capacitor manufacturers. TI recommends that both the manufacturers and the manufacturers series that are listed in [Table 1](#) be used.

In this example, through hole aluminum electrolytic capacitors from several different manufacturers are available:

- 82-μF, 35-V Panasonic HFQ Series
- 82-μF, 35-V Nichicon PL Series

3. The capacitor voltage rating must be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are required to satisfy the low ESR requirements required for low output ripple voltage.

For a 20-V output, a capacitor rating of at least 30 V or more is required. In this example, either a 35-V or 50-V capacitor would work. A 35-V rating was chosen although a 50-V rating could also be used if a lower output ripple voltage is required.

Other manufacturers or other types of capacitors may also be used, provided the capacitor specifications (especially the 100 kHz ESR) closely match the types listed in [Table 1](#). Refer to the capacitor manufacturers data sheet for this information.

9.2.2.2.4 Feedforward Capacitor (C_{FF})

For output voltages greater than approximately 10 V, an additional capacitor is required (use [Equation 6](#); see [Figure 45](#)). The compensation capacitor is typically between 50 pF and 10 nF, and is wired in parallel with the output voltage setting resistor, R_2 . It provides additional stability for high output voltages, low input or output voltages, or very low ESR output capacitors, such as solid tantalum capacitors.

$$C_{FF} = \frac{1}{31 \times 10^3 \times R_2} \quad (6)$$

This capacitor type can be ceramic, plastic, silver mica, etc. (Because of the unstable characteristics of ceramic capacitors made with Z5U material, they are not recommended.)

The table shown in [Table 1](#) contains feedforward capacitor values for various output voltages. In this example, a 1-nF capacitor is required.

9.2.2.2.5 Catch Diode Selection (D1)

1. The catch diode current rating must be at least 1.3 times greater than the maximum load current. Also, if the power supply design must withstand a continuous output short, the diode must have a current rating equal to the maximum current limit of the LM2598. The most stressful condition for this diode is an overload or shorted output condition.

See [Table 5](#). Schottky diodes provide the best performance, and in this example a 3-A, 40-V, 1N5822 Schottky diode is a good choice. The 3-A diode rating is more than adequate and does not overstressed even for a shorted output.

2. The reverse voltage rating of the diode must be at least 1.25 times the maximum input voltage.
3. This diode must be fast (short reverse recovery time) and must be placed close to the LM2598 using short leads and short printed circuit traces. Because of their fast switching speed and low forward voltage drop, Schottky diodes provide the best performance and efficiency, and must be the first choice, especially in low output voltage applications. Ultra-fast recovery or high-efficiency rectifiers are also good choices, but some types with an abrupt turnoff characteristic may cause instability or EMI problems. Ultra-fast recovery diodes typically have reverse recovery times of 50 ns or less. Rectifiers such as the 1N4001 series must not be used because they are too slow.

9.2.2.2.6 Input Capacitor (C_{IN})

A low ESR aluminum or tantalum bypass capacitor is required between the input pin and ground to prevent large voltage transients from appearing at the input. In addition, the RMS current rating of the input capacitor must be selected to be at least $\frac{1}{2}$ the DC load current. The capacitor manufacturers data sheet must be checked to assure that this current rating is not exceeded. [Figure 31](#) shows typical RMS current ratings for several different aluminum electrolytic capacitor values.

This capacitor must be located close to the IC using short leads and the voltage rating must be approximately 1.5 times the maximum input voltage.

If solid tantalum input capacitors are used, it is recommended that they be surge current tested by the manufacturer.

Use caution when using a high dielectric constant ceramic capacitor for input bypassing, because it may cause severe ringing at the V_{IN} pin.

The important parameters for the input capacitor are the input voltage rating and the RMS current rating. With a nominal input voltage of 28 V, an aluminum electrolytic capacitor with a voltage rating greater than 42 V ($1.5 \times V_{IN}$) is required. Because the next higher capacitor voltage rating is 50 V, a 50-V capacitor must be used. The capacitor voltage rating of ($1.5 \times V_{IN}$) is a conservative guideline, and can be modified somewhat if desired.

The RMS current rating requirement for the input capacitor of a buck regulator is approximately $\frac{1}{2}$ the DC load current. In this example, with a 1-A load, a capacitor with a RMS current rating of at least 500 mA is required.

Figure 31 shows curves that can be used to select an appropriate input capacitor. From the curves, locate the 50-V line and note which capacitor values have RMS current ratings greater than 500 mA. Either a 100- μ F or 120- μ F, 50-V capacitor could be used.

For a through-hole design, a 120- μ F, 50-V electrolytic capacitor (Panasonic HFQ series or Nichicon PL series or equivalent) would be adequate. Other types or other manufacturers' capacitors can be used provided the RMS ripple current ratings are adequate.

For surface-mount designs, solid tantalum capacitors can be used, but caution must be exercised with regard to the capacitor surge current rating (see [Input Capacitor \(\$C_{IN}\$ \)](#)). The TPS series available from AVX, and the 593D series from Sprague are both surge current tested.

9.2.2.3 Application Curves

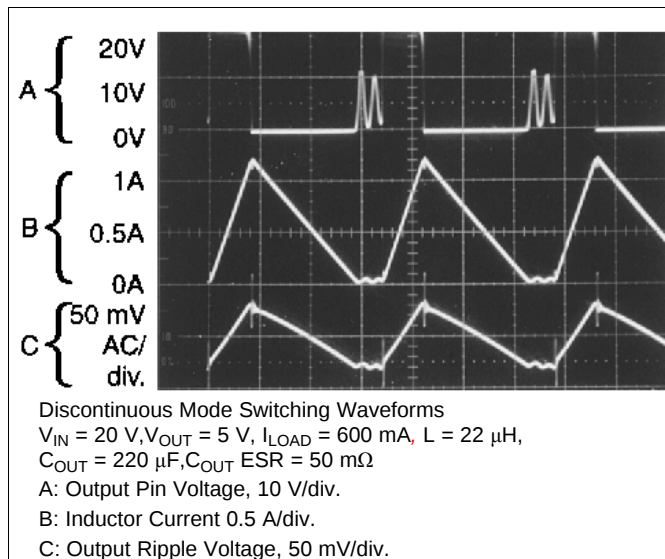


Figure 46. Horizontal Time Base: 2 μ s/div

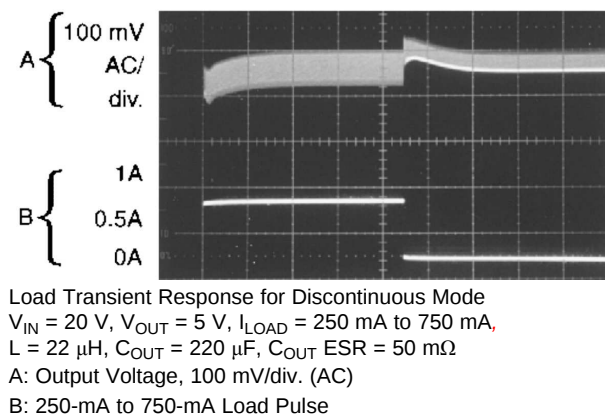


Figure 47. Horizontal Time Base: 200 μ s/div

10 Power Supply Recommendations

The LM2598 is designed to operate from an input voltage supply up to 40 V. This input supply must be well regulated and able to withstand maximum input current and maintain a stable voltage.

11 Layout

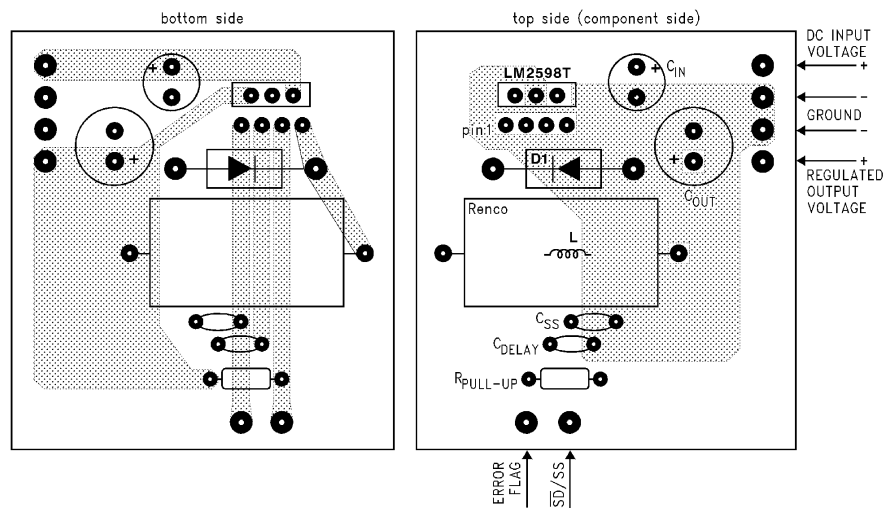
11.1 Layout Guidelines

As in any switching regulator, layout is very important. Rapidly switching currents associated with wiring inductance can generate voltage transients which can cause problems. For minimal inductance and ground loops, the wires indicated by heavy lines must be wide printed circuit traces and must be kept as short as possible. For best results, external components must be placed as close to the switcher IC as possible using ground plane construction or single point grounding.

If open core inductors are used, take special care regarding the location and positioning of this type of inductor. Allowing the inductor flux to intersect sensitive feedback, IC groundpath and C_{OUT} wiring can cause problems.

When using the adjustable version, special care must be taken as to the location of the feedback resistors and the associated wiring. Physically place both resistors near the IC, and route the wiring away from the inductor, especially an open core type of inductor (see [Open Core Inductors](#) for more information).

11.2 Layout Examples



C_{IN} —150- μ F, 50-V Aluminum Electrolytic, Panasonic *HFQ series*

C_{OUT} —120- μ F, 25-V Aluminum Electrolytic, Panasonic *HFQ series*

D1 — 3-A, 40-V Schottky Rectifier, 1N5822

L1 — 68- μ H, L30, Renco, Through hole

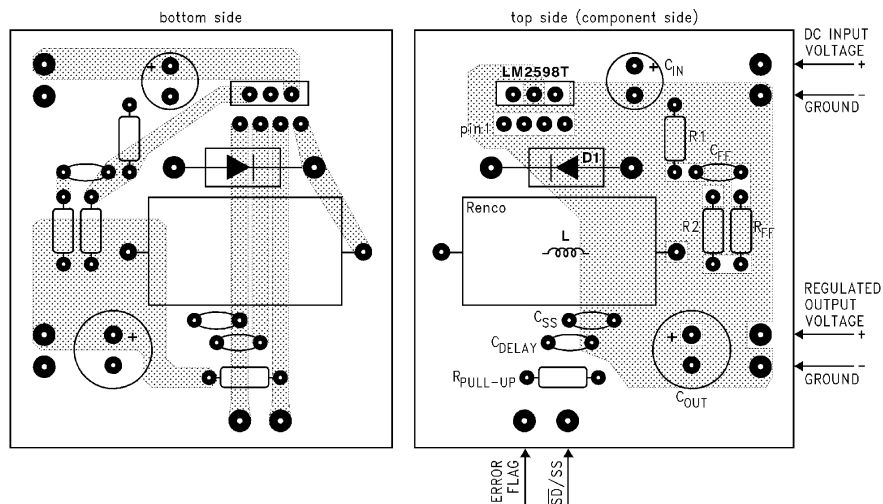
$R_{PULL-UP}$ — 10 k Ω

C_{DELAY} — 0.1 μ F

$C_{SD/SS}$ — 0.1 μ F

Figure 48. Typical Through-Hole PCB Layout, Fixed Output (1x Size), Double-Sided, Through-Hole Plated

Layout Examples (continued)



C_{IN} — 150- μ F, 50-V, Aluminum Electrolytic, Panasonic *HFQ series*

C_{OUT} — 120- μ F, 25-V Aluminum Electrolytic, Panasonic *HFQ series*

D1 — 3-A, 40-V Schottky Rectifier, 1N5822

L1 — 68- μ H, L30, Renco, Through hole

R1 — 1 k Ω , 1%

R2—Use formula in Design Procedure

C_{FF} —See [Feedforward Capacitor \(\$C_{FF}\$ \)](#).

R_{FF} —See [Feedforward Capacitor \(\$C_{FF}\$ \)](#).

$R_{PULL-UP}$ —10 k Ω

C_{DELAY} — 0.1- μ F

$C_{SD/SS}$ — 0.1 μ F

Figure 49. Typical Through-Hole PCB Layout, Adjustable Output (1x Size), Double-Sided, Through-Hole Plated

11.3 Thermal Considerations

The LM2598 is available in two packages: a 7-pin TO-220 (T) and a 7-pin surface mount DPAK (S).

The TO-220 package can be used without a heat sink for ambient temperatures up to approximately 50°C (depending on the output voltage and load current). [Figure 40](#) shows the LM2598T junction temperature rises above ambient temperature for different input and output voltages. The data for these curves was taken with the LM2598T (TO-220 package) operating as a switching regulator in an ambient temperature of 25°C (still air). These temperature rise numbers are all approximate and there are many factors that can affect these temperatures. Higher ambient temperatures require some heat sinking, either to the PCB or a small external heat sink.

Thermal Considerations (continued)

The DDPAK surface mount package tab is designed to be soldered to the copper on a printed-circuit board (PCB). The copper and the board are the heat sink for this package and the other heat producing components, such as the catch diode and inductor. The PCB copper area that the package is soldered to must be at least 0.4 in², and ideally must have 2 or more square inches of 2 oz. (0.0028 in) copper. Additional copper area improves the thermal characteristics, but with copper areas greater than approximately 3 in², only small improvements in heat dissipation are realized. If further thermal improvements are required, TI recommends double-sided or multilayer PCB with large copper areas.

[Figure 41](#) shows the LM2598S (DDPAK package) junction temperature rise above ambient temperature with a 1-A load for various input and output voltages. This data was taken with the circuit operating as a buck switching regulator with all components mounted on a PCB to simulate the junction temperature under actual operating conditions. This curve can be used for a quick check for the approximate junction temperature for various conditions, but be aware that there are many factors that can affect the junction temperature.

For the best thermal performance, wide copper traces and generous amounts of PCB copper must be used in the board layout. (One exception to this is the output (switch) pin, which must not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

Package thermal resistance and junction temperature rise numbers are all approximate, and there are many factors that affect these numbers. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are trace width, total printed-circuit copper area, copper thickness, single- or double-sided multilayer board, and the amount of solder on the board. The effectiveness of the PCB to dissipate heat also depends on the size, quantity, and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode adds heat to the PCB and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material, and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.

12 Device and Documentation Support

12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.2 Trademarks

E2E is a trademark of Texas Instruments.

SIMPLE SWITCHER is a registered trademark of Texas Instruments.

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12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM2598S-12/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -12 P+	Samples
LM2598S-3.3/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -3.3 P+	Samples
LM2598S-5.0	NRND	DDPAK/ TO-263	KTW	7	45	TBD	Call TI	Call TI	-40 to 125	LM2598S -5.0 P+	
LM2598S-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -5.0 P+	Samples
LM2598S-ADJ/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -ADJ P+	Samples
LM2598SX-12/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -12 P+	Samples
LM2598SX-3.3/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -3.3 P+	Samples
LM2598SX-5.0	NRND	DDPAK/ TO-263	KTW	7	500	TBD	Call TI	Call TI	-40 to 125	LM2598S -5.0 P+	
LM2598SX-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -5.0 P+	Samples
LM2598SX-ADJ/NOPB	ACTIVE	DDPAK/ TO-263	KTW	7	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LM2598S -ADJ P+	Samples
LM2598T-12/NOPB	ACTIVE	TO-220	NDZ	7	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LM2598T -12 P+	Samples
LM2598T-3.3/NOPB	ACTIVE	TO-220	NDZ	7	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LM2598T -3.3 P+	Samples
LM2598T-5.0/NOPB	ACTIVE	TO-220	NDZ	7	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LM2598T -5.0 P+	Samples
LM2598T-ADJ/NOPB	ACTIVE	TO-220	NDZ	7	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LM2598T -ADJ P+	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2598SX-12/NOPB	DDPAK/TO-263	KTW	7	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM2598SX-3.3/NOPB	DDPAK/TO-263	KTW	7	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM2598SX-5.0	DDPAK/TO-263	KTW	7	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM2598SX-5.0/NOPB	DDPAK/TO-263	KTW	7	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM2598SX-ADJ/NOPB	DDPAK/TO-263	KTW	7	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

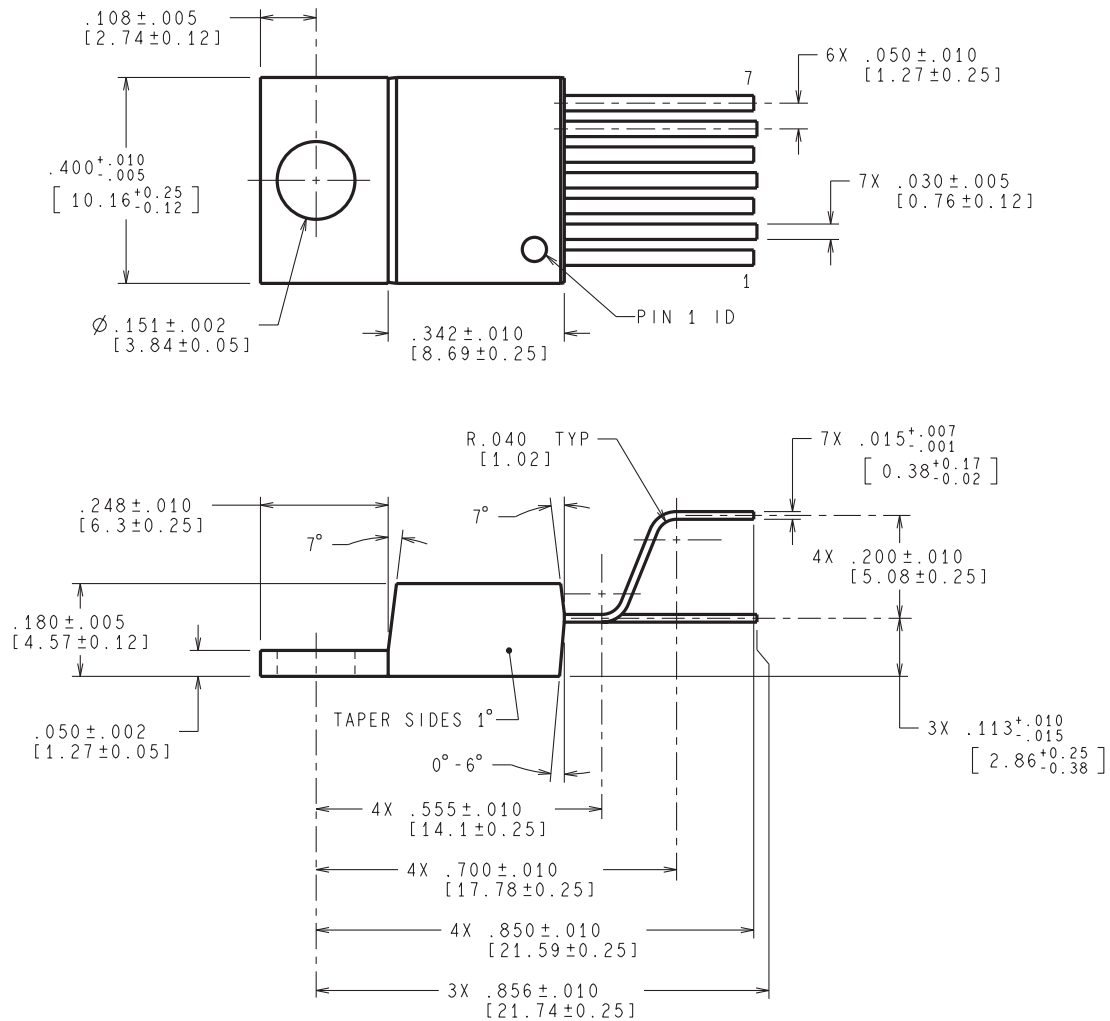
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2598SX-12/NOPB	DDPAK/TO-263	KTW	7	500	367.0	367.0	45.0
LM2598SX-3.3/NOPB	DDPAK/TO-263	KTW	7	500	367.0	367.0	45.0
LM2598SX-5.0	DDPAK/TO-263	KTW	7	500	367.0	367.0	45.0
LM2598SX-5.0/NOPB	DDPAK/TO-263	KTW	7	500	367.0	367.0	45.0
LM2598SX-ADJ/NOPB	DDPAK/TO-263	KTW	7	500	367.0	367.0	45.0

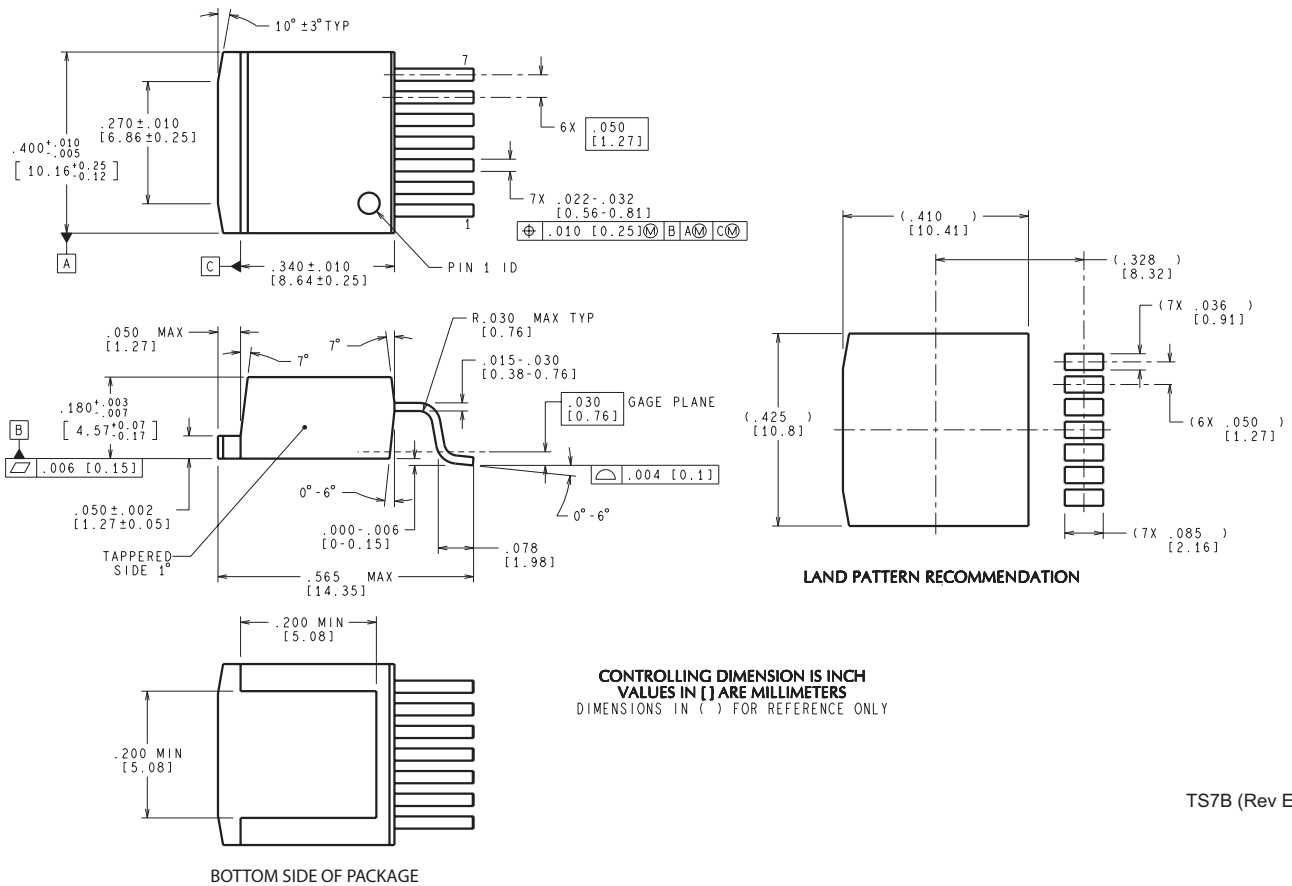
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